



CEATEC 2025

**EXHIBITION
REPORT**

October 14 (Tue) ▶ 17 (Fri), 2025
Makuhari Messe

Organizer

JEITA

Japan Electronics and Information Technology Industries Association

Co-sponsors

CIAJ

Communications and Information network Association of Japan

**Software
Association
Japan**

Software Association of Japan

CEATEC 2025

Topics

CEATEC 2025, held under the theme “Innovation for All,” aimed not only to showcase cutting-edge technologies but also to demonstrate how technology can meaningfully contribute to real society and daily life. This event sought to inspire public engagement and accelerate the social implementation of innovation.

The exhibition consisted of four area—General Exhibits area, Partners & Global Park, AX (AI Transformation) Park, and the Next Generation Park—bringing together 810 companies and organizations in total. Among them, 156 exhibitors came from 29 countries and regions, and notably, the number of participating startups, universities, and research institutions reached a record high of 232 organizations, highlighting the strong presence of diverse next-generation innovators.

The conference program, held alongside the exhibition, featured 226 sessions, including pitch events, encouraging active discussions and networking among participants. This year at CEATEC 2025, the total registered attendance during the event reached 98,884 visitors.

On the evening of opening day, October 14 (Tue), an Opening Reception was held at the Palace Hotel Tokyo. Following remarks by Kei Uruma, Chairperson of JEITA, a video message from Prime Minister Shigeru Ishiba was presented. Distinguished guests—including Masaaki Taira, the Minister of Digital Agency, Yuichiro Koga, Vice Minister of Economy, Trade and Industry, Hideto Kawasaki, Parliamentary Vice-Minister for Internal Affairs, and Toshiaki Higashihara Vice Chair of Keidanren—delivered congratulatory messages. Approximately 700 attendees, including corporate executives, embassy representatives, and government officials, deepened exchanges throughout the event.

On the third day of the event, Thursday, October 16, Prime Minister Shigeru Ishiba visited the exhibition venue — the first visit ever by an incumbent Prime Minister. He viewed advanced technologies such as AI-powered driver skill analysis systems and expressed strong interest in various exhibits. Numerous leaders from government and public agencies, including the Minister for Digital Agency, also visited, making CEATEC a major platform for sharing the latest industry trends and technological innovation.

Area Overview

AX Park

A hub for cutting-edge AI-related technologies—including generative AI, industrial AI, communications infrastructure, voice and image recognition, and security—offering deep insights into the AI-driven era.

General Exhibits

A zone focused on technologies and solutions shaping a future society empowered by AI—covering electronic components, devices, and a wide range of services.

Next Generation Park

(Startups & Universities)
A co-creation space aimed at building a “next-generation innovation ecosystem,” where startups, universities, research institutions, corporate new-business teams, and supporters gather to generate new value.

Partners & Global Park

A collaborative area shaped around diverse themes such as well-being and sustainability, demonstrating the essence of Society 5.0 through cross-industry partnerships.

Conference

226+ sessions held both at Makuhari Messe and online, including open-stage talks inside the exhibition halls.
A real-time AI translation system supporting 60+ languages was deployed to enhance accessibility.

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Visitor Profile

Number of Visitors

98,884Automotive,
transportation equipment**3,000**Manufacturing, equipment,
precision equipment**11,000**Electronics, information and
communications equipment**4,000**Electronic components,
electronic devices**7,000**

Communications services

3,000Information processing,
information services**5,000**

Software

3,000Housing, construction,
real estate and property**3,500**

Civil services, public organizations

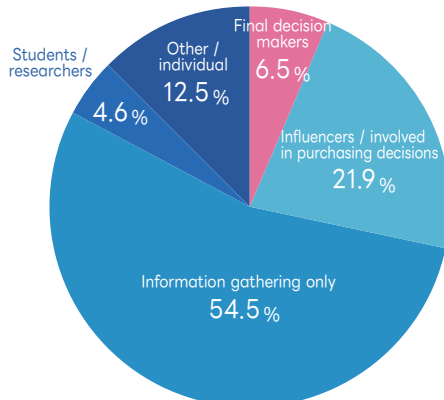
3,500

Students

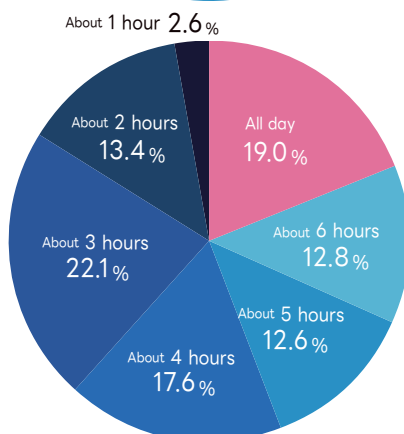
8,000

The above figures are approximate.

Segmentation



Duration of visit



Exhibitor Profile

Total exhibitors

810 companies / organizations

Startups / universities / research institutions

232

Overseas exhibitors

156 from **29** countries / regions

CONFERENCE

Number of sessions

226

Speakers

655

Total registered attendees

27,621

PR & Promotion Data

Registered press

635 members

Japanese newspaper articles

300+

Japanese TV coverage

total 2 hours 26 minutes 54⁴⁷ seconds broadcast

CEATEC[®] AWARD

CEATEC AWARD 2025 recognizes outstanding projects, technologies, products, services, and supporting software, components, and devices that contribute to the realization of Society 5.0, the creation of new value and markets, and the revitalization of related industries. The winners were selected through a rigorous review process conducted by the CEATEC AWARD 2025 Judging Committee. On October 7, one week before the exhibition, the Ministerial Awards and Category Awards were announced, followed by a simple pre-exhibition showcase for media interviews.



Compact and Lightweight LEO Satellite Communication User Terminal Integrated with Electronically-steered Phased Array Antenna (prototype)

SHARP Corporation

Booth 3H223

Prototype of a compact and lightweight low earth orbit (LEO) satellite communication user terminal integrated with electronically steered phased array antenna utilizing miniaturization and lightweight design technologies and communications technologies accumulated through the development of smartphones. This terminal device is applicable for various uses such as construction and agricultural machineries, vessels and ships, vehicles, drones and more.



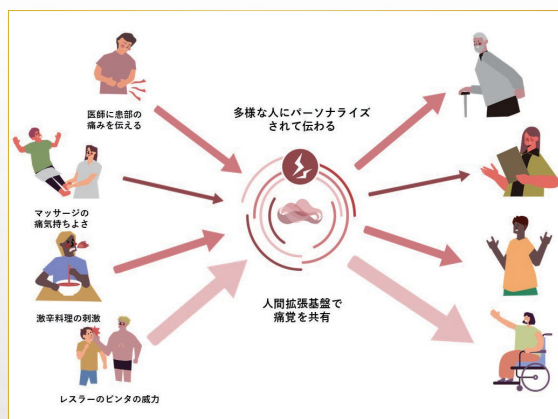
A Platform for Deepening Mutual Interpretations Through Pain Sharing

NTT Docomo, Inc.

Booth 1H007

This is the world's first* platform technology for sharing the perception of pain—one of the more difficult human sensations to put into words. Conveying to another the physical and psychological pain one feels is challenging: the other party often has to rely on subjective interpretations, making objective analysis difficult. However, this technology makes it possible to experience and appreciate another person's pain as if it were one's own. As well as contributing to better communication in healthcare, it can be used to support victims of abusive behavior and defamation on social media.

*Source: NTT DOCOMO



Mask Voice Clip—A Mask-Attached Device for Achieving Reliable Voice Input in the AI Era

Murata Manufacturing Co., Ltd.

Booth 2H325

With the evolution of large language models (LLMs), the sort of natural language operations—including data input and record-keeping—that until now seemed futuristic are fast becoming reality. However, they demand reliable voice input, which the hardware of this device is able to deliver. By detecting minute vibrations on the mask surface with a piezoelectric film sensor, it can extract just the voice of the mask-wearer, in real time and with high accuracy—even in noisy environments and when other people are talking at the same time. This technology facilitates the adoption of AI in many different fields, such as healthcare and manufacturing, as well as for maintenance inspections, etc.



CEATEC AWARD 2025 Review Panel of Judges

Academic Society Representatives (in no particular order)

Information Processing Society of Japan / Institute of Electronics, Information and Communication Engineers / Institute of Image Information and Television Engineers / Nagoya University

Research Institutes and Media-related Organizations (in no particular order)

MM Research Institute Co., Ltd. / Nikkan Kogyo Shimbum / Nikkei BP Research Institute / IT Media Co., Ltd. / Techno Core Co., Ltd. / WovenCapital

Observers (in no particular order)

Ministry of Internal Affairs and Communications / Ministry of Economy, Trade and Industry / Digital Agency (in order of establishment)

Japan Electronics and Information Technology Industries Association (JEITA) *CEATEC 2025 Organizing Organization

Japan Information and Communications Network Industry Association (CIAJ) *CEATEC 2025 Co-organizing Organization

Japan Software Association (SAJ) *CEATEC 2025 Co-organizing Organization

Japan Automobile Manufacturers Association, Inc. (JAMA) *CEATEC 2025 Supported Organization

Tribeat Co., Ltd.



Innovation Category Award

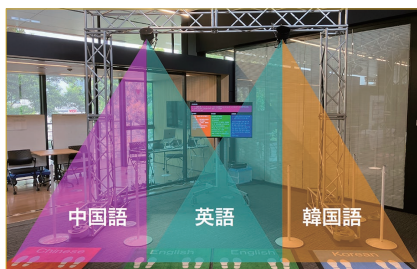


ZINNSIA—A Sensor Interface that Transforms a Broad Range of Materials into Touch Controls and Switches

Japan Display Inc.

Booth 2H202

ZINNSIA is an innovative, high-sensitivity sensor interface that transforms a broad range of materials including wood, stone fabric, and drywall. For instance, one can step on a floor surface to turn on the light intuitively by installing the sensor underside a floor. The sensor comes in a sheet form, which can be simply attached to the back of a material, enabling for flexible installation tailored to the shape and application. It provides new interactive experiences while enhancing freedom in spatial design without compromising material texture or aesthetic appeal.

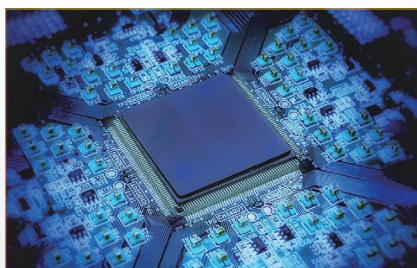


Multilingual Simultaneous Translation and Multiple Sound Spot Synthesis

National Institute of Information and Communications Technology (NICT)

Booth 1H009

NICT's solution combines AI-powered multilingual simultaneous interpretation with multiple sound spot technology. By segmenting speech recognition results into shorter units (chunks) for real-time translation, the system delivers fast and accurate interpretation of continuous speech. In parallel, through combinations of multiple speakers, the system provides synthesized audio for each language area, while also displaying the translated text on screen.

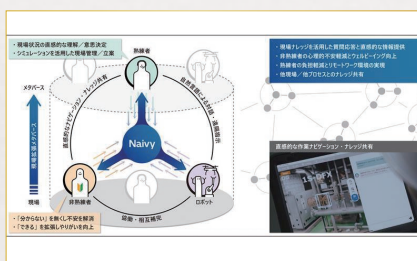


A Sensor System with Real-time Learning Using an Analog Reservoir AI Chip for Edge Computing

TDK Corporation

Booth 6H180

Power consumption and latency due to reliance on cloud AI by generative AI are major obstacles to the development of AI. Reservoir AI is technology that mimics the human cerebellum and excels at processing time-series information for robotics, human interfaces and so forth. Reservoir AI can reduce the size of the learning part in the reservoir through natural phenomena and can be applied to sensors tailored to the user's individuality through real-time learning while using AI with edge applications.



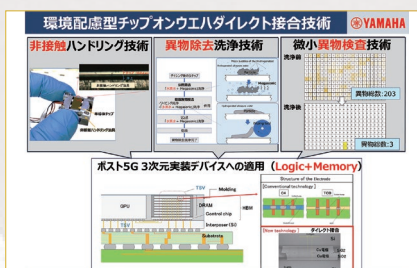
Frontline Coordinator - Naivy: Next-generation AI Agent

Hitachi, Ltd.

Booth 5H220

Naivy is an AI agent developed to support on-site operational decision-making by personnel engaged in manufacturing, inspections, maintenance, etc. AI has been harnessed for use in the physical domain to improve the efficiency of workers at the same time as reducing their workload. AI performs real-time analysis of what is happening on site and compares this with domain knowledge stored in a proprietary metaverse space. This world-first* technology is thus able to identify the equipment requiring attention. It then provides on-site personnel with intuitive and easy-to-understand navigation for appropriate work procedures according to the situation

*Source: Hitachi, Ltd.



Chip-on-wafer Direct Bonding Technology that is Environmentally Friendly

Yamaha Robotics Co., Ltd.,
AIST, Tokyo University of Science

Booth 4H220

To manufacture the advanced devices required in a post-5G society, it is necessary to use direct bonding to join multiple semiconductor chips in a 3D configuration with chip-on-wafer technology. However, conventional methods result in foreign particles being left on the surface of semiconductor chips after wafer dicing; this residue affects bonding quality and prevents practical application of 3D stack technology. To solve this problem, technologies have been developed (1) to clean and pre-treat the semiconductor chip surface, and (2) to implement completely non-contact chip handling.



Heart Rate Sensing for Bathing

Rinnai Corporation

Booth 1H318

To achieve sustainably healthy and enriched living, Rinnai starts by sensing heart rate during daily bathing activities to predict physical and mental states, provide feedback on effects of bathing, and propose personalized bathing methods, and relaxation and lifestyle habits. Rinnai has created this electrocardiogram measurement module for bathing.



Next Generation Category Award



Feel It, Touch It—The Next Generation of 4D Video

TouchStar (Commercialization Project, Tohoku University)

Booth 5H322

As a next-generation vibration feedback technology that goes beyond the conventional limits of smartphone vibrators, TouchStar delivers natural and immersive haptic experiences. Utilizing a proprietary algorithm that originated from university research, TouchStar enhances both video and audio with a vivid sense of physical realism through a faithful reproduction of a wide-range of haptic sensations—from high to low frequencies. At the show floor, the group of researchers from Tohoku University unveiled experiential content for the first time, integrating smartphones with digital signage, while showcasing the potential for new experiential content that conveys the skill and subtle breathing of performers.



ReaLab AI - Autonomous AI Agents Powering the Research Landscape, from Exploration to Lab Experiments

Rohto Pharmaceutical Co., Ltd. / Hutzper Inc.

Booth 6H150

Target Discovery AI Orchestrator for Healthcare and Life Sciences:

An AI agent for all R&D areas requiring target discovery. Automatically creates experiment designs based on understanding of researcher intentions, and automatically finds and evaluates optimal gene expression data from public databases. Large-scale bioinformatics analysis is then performed seamlessly in the cloud. Generative AI manages and automates the entire process, enabling rapid and reproducible drug target candidate discovery, regardless of expertise. Practicality has been proven by Rohto Pharmaceutical.

"Dual-agent AI for Autonomous Prescription Design and Experiment Execution":

An AI platform that integrates prescription research and robotic experimentation, automatically generating "design → plan → execute → record" by simply instructing researchers in natural language. This is not just a research-level trial, but a system in which AI interprets and converts complex control rules for experiment robots to prevent mistaken operations and ensure reproducibility and safety while also handling actual operations. The technology can be deployed in various fields such as cosmetics, pharmaceuticals, chemicals and foods, and its practicality has already been demonstrated by Rohto Pharmaceutical, a co-developer of the product.



Co-Creation Category Award



Cross-industry Co-creation Transforming Beauty & Healthcare— Future Innovation Driven by RNA from KAO, istyle, and KIRIN

RNA Co-Creation Consortium

Booth 4H213

In the beauty and healthcare markets, a wide range of product offerings continues to drive market growth. However, from the consumer's perspective, the overwhelming abundance of products and information makes it increasingly difficult to identify what truly provides value for them. RNA Co-Creation Consortium provides a cross-industry framework that enables personalized product selection and delivery. Through their newly developed classification technology based on gene expression data (skin gene expression mode analysis) and co-creation with Japan's largest beauty platform as well as leading beauty and healthcare manufacturers, the consortium is driving societal transformation.



Global Category Award



Code Metal - Generate Verified, Hardware-Ready Code with Provable AI

Code Metal, Inc.

Booth 5H013

We nominate Code Metal for the CEATEC AWARD 2025. Code Metal is transforming software development in automotive, robotics, industrial, and semiconductor industries by enabling seamless translation of code across environments. Its platform allows customers to move between programming languages and optimize for diverse hardware targets with unprecedented speed. By combining state-of-the-art AI with rigorous formal methods, Code Metal has created a first-of-its-kind trustworthy AI system. The platform integrates directly with existing customer code bases and provides transparent, traceable reporting of every development task. Processes that traditionally take months or years are now completed in days, accelerating innovation while maintaining reliability. This breakthrough empowers organizations to modernize workflows, unlock efficiency, and bring advanced products to market faster than ever before. Already adopted by Fortune 100 companies, Code Metal is demonstrating the real-world benefits of trustworthy AI in industries where such advances were once out of reach.



Mobility Category Award

Selected from startup exhibitors at this year's Japan Mobility Show 2025 (Thursday, October 30 - Sunday, November 9, Tokyo Big Sight), this CEATEC AWARD 2025 is presented to companies evaluated for their potential for practical application and contribution to society.

Feeling

Humonii (Japan Mobility Show 2025, Startup Exhibitor)

One in three wheelchair users tend to suffer from depression, which is an enormous psychological toll. Therefore, wheelchair users need support to give them a sense of self-efficacy and lead proactive lives. Humonii's "Feeling," is an all-in-one hands-free semi-automatic wheelchair with core-based operation that supports a proactive future from the time of hospitalization to self-actualization after discharge, such as 1) Proactive in-hospital living in hospitals and nursing homes, 2) Expansion of work that the user can handle, 3) Support for participation in sports and recreation, etc.





This new program, launched in collaboration with the Japan Association for the Promotion of the Event Industry (JACE), aims to define what sustainable and engaging exhibitions of the future should be. By encouraging the creation of spaces that offer “excitement” to visitors while prioritizing environmental responsibility, the initiative supports the development of new value and market growth across the industry.

Judging Committee

Japan Association for the Promotion of Creative Events
Sustainability Committee
Japan Electronics and Information Technology Industries Association
Design Board

CEATEC 2025 Eco & Design Challenge Award of Excellence



NEC Personal Computers Ltd.

Booth 2H411

NEC Personal Computers created a spacious and thoughtfully structured layout with interactive exhibits and experiential elements. The LED-based exterior had strong visual impact from afar, while coordinated lighting and flooring aligned with brand colors to establish unity across the space. Despite increased emissions from large LED panels, NEC Personal Computers reduced waste and improved logistics efficiency for long-distance transport. In addition, the booth featured exhibits dedicated to sustainability initiatives, contributing to its high evaluation.



SHARP Corporation

Booth 3H223

Despite having only six booth units, SHARP delivered excellent flow design with a four-sided open layout that invited visitors from all directions. The booth featured high-UX displays conveying the company's brand vision, while CO₂ reduction efforts were evident through reusable novelties and staff uniforms shared across multiple events. Although rental fixtures were widely used, the unified gray tone and effective lighting elevated the refreshed brand identity. SHARP also achieved one of the lowest CO₂ emissions per booth unit, earning high evaluation as a model for the Eco & Design Challenge.



Sony Group Corporation

Booth 6H303

With translucent fabric walls and fixtures, Sony created a soft yet sophisticated space with strong branding impact. Efforts toward sustainability extended across booth structures, promotional items, uniforms, and even energy use through green power, offsetting the increased footprint of monitor displays. The layout emphasized hospitality—clear visitor guidance, accessibility measures such as UD Talk, balanced staffing, and inclusion across multiple booth functions.

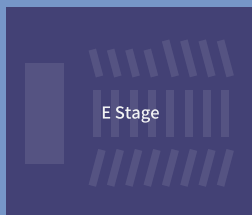


TDK Corporation

Booth 6H180

TDK organized the booth into two zones, “Work” and “Life,” making it easy for visitors—students included—to understand how their technologies integrate into daily life. Lightweight and compact collapsible furniture (molo) was used to create a gentle impression while improving transport efficiency. Sustainability considerations guided the entire production process, including supplier selection, and the booth's structure demonstrated reproducibility for other exhibitions.

Venue MAP



E Stage

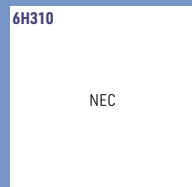


TDK

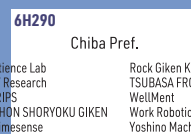


Hitachi

5H020



NEC

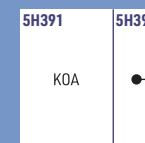


Chiba Pref.

Artience Lab
CV Research
GRIPS
NIHON SHORYOKU GIKEN
Primesense
Rock Giken Kogyo
TSUBASA FRONTIER
WellMent
Work Robotics
Yoshino Machinery



Kanadevia



KOA

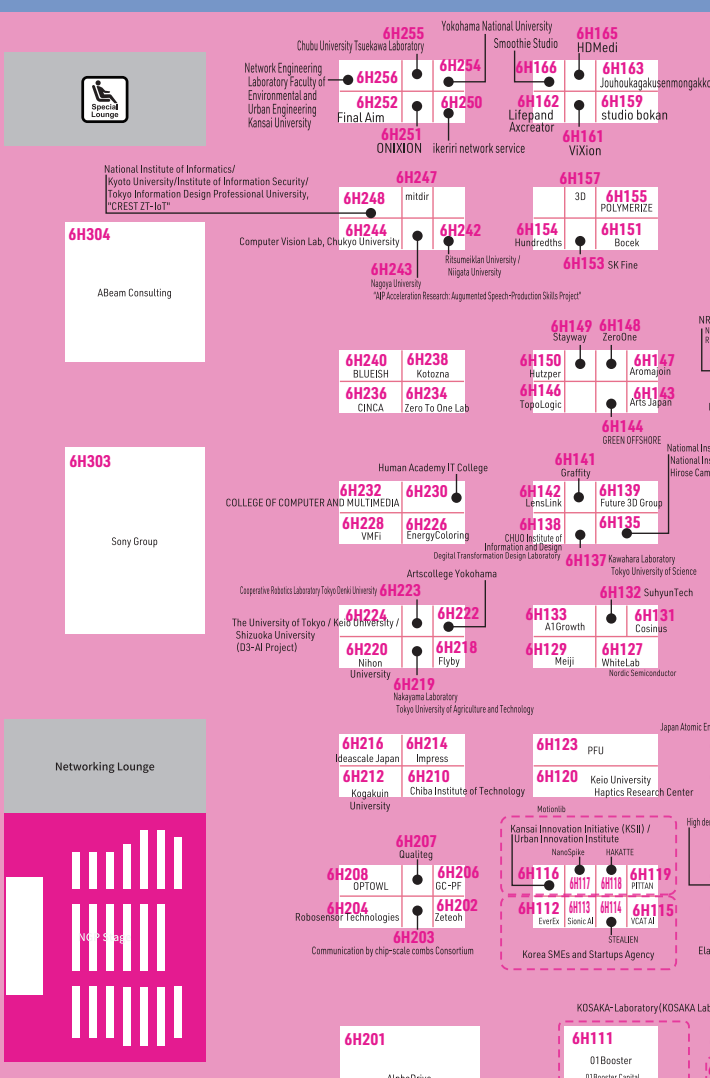


Cabinet Office National Space Policy Secretariat/
Quasi-Zenith Satellite System Services

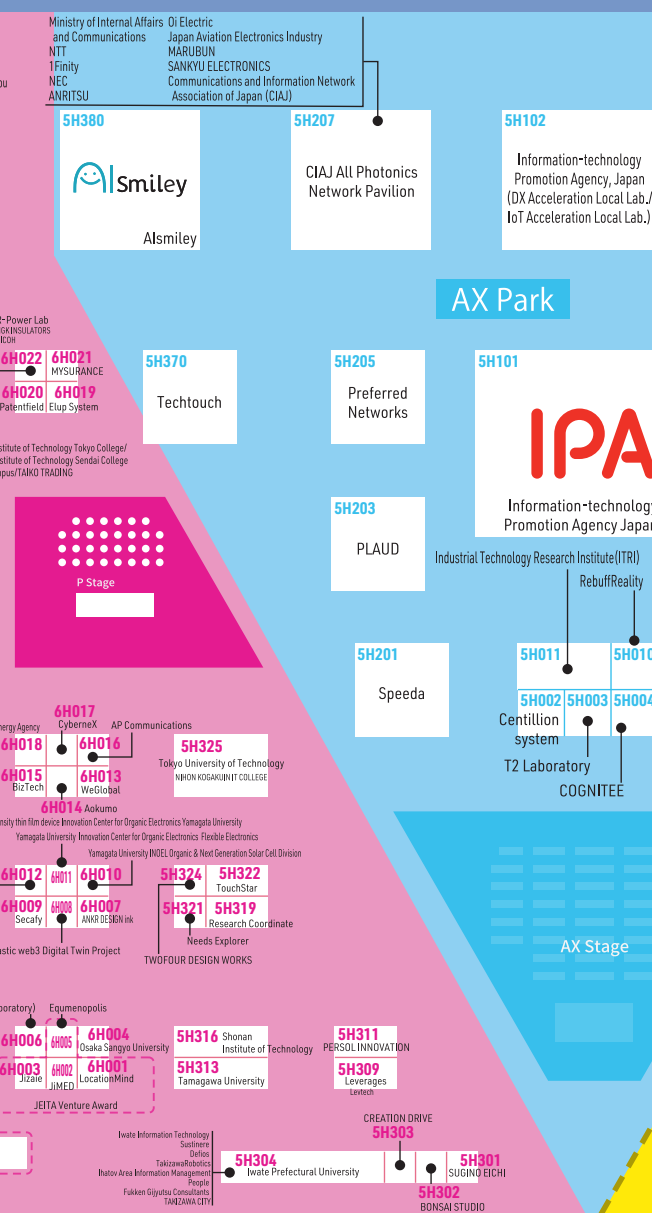


ANRITSU

General Exhibits



Next Generation Park



HALL 6

HALL 5

Venue MAP

ASAHI ETIC
Upside
Archelis
Area Japan
COSMO INSTRUMENTS
Konno
Sonas
FOVE
Foretosea
MAZIN
Morphy
Luce Search
FLARE SYSTEMS
iPresence
ASTRODESIGN
VR Design Institute
IIGA
Idags
Magna Wireless
Haloworld

3H412



TOKYO METROPOLITAN INDUSTRIAL
TECHNOLOGY RESEARCH INSTITUTE

3H223

SHARP

SHARP

2H325

muRata

INNOVATOR IN ELECTRONICS

Murata Manufacturing

3H411

SFI ELECTRONICS TECHNOLOGY
LENOO ELECTRONICS
T-GLOBAL TECHNOLOGY
HIGGSTEC
IRIS OPTRONICS
TAIWAN ALPHA ELECTRONIC
EXPLUS
CONQUER ELECTRONICS
KINGSTATE ELECTRONICS
SUPERIOR TECH

Taiwan Electrical and
Electronic Manufacturers'
Association

AV-LEADER
GT CONTACT
HITPOINT
SUNCA
CHANGING INFORMATION TECHNOLOGY
SIC TECHNOLOGY

3H410

Analog Devices

3H409

CRI Middleware

3H408

Central Nippon Expressway Company

3H222

公益財団法人 東京都中小企業振興公社

Tokyo Metropolitan Small and
Medium Enterprise Support Center
(Tokyo Business Frontier)

3H011

KODENSHI

2H324

Speeda

3H307

Nagase

3H308

Yokowo

3H306

RainScales
Japan

Trenser Technology Solutions

Sumitomo Metal Mining

Kanazawa University

SI Synergy
Technology

3H218 3H217

3H216

3H215

Zenken

3H214

SANYO
CHEMICAL
INDUSTRIES

3H221 MOUBIC

Goochain Technology

VALUENEX Japan

3H111 MORISO

3H110 Iwata

3H109 Niigata City

3H107

PowerManagement

3H010

3H008

3H007

Foster Electric Company

Crystals Technology

2H419 Elektron

2H420 AI Samurai

2H421

2H422

Merici

2H415 Sinumy

2H418 Industrial Property
Cooperation
Center

2H321

YEEBO DISPLAY
TAIWAN BRANCH

2H320

2H323

2H319

DKE Holding

City of Ishikari Hokkaido

NHK Foundation

GUANGDONG KINGBALI NEW MATERIAL

3H304

Hokuriku region
liaison conference for
attracting enterprise

3H305 3H303

3H302

Iofit

HOKURIKU ELECTRIC
INDUSTRYToyama Pref.
Ishikawa Pref.
Fukui Pref.
Hokuriku Economic Federation

3H407

LegalOn Technologies

3H512 3H511

3H514 YSL
Solution

3H515 CNA

3H509 HELATH

3H508

3H507 SEMITEC

Residential Devices
Co-Creation Organization

TOYOTA MOTOR Heat Flux Sensor "Energy flow"

3H504 3H503

3H502

3H501

Wovn Technologies

EKO METAL
INDUSTRIESInter-enterprise Information Sharing
Consortium NEXCHAINMonotechnosp
Tokyo University of Information SciencesTourism Forecast Platform Promotion Team
Blogwatcher JAPAN TRAVEL AND TOURISM ASSOCIATION
Jordan JTB
Opentone

PACIFIC CONSULTANTS

3H401

FPT Japan
Holdings

3H212

Fujikura

3H213 3H211

3H210

Musignal

VRC

ADOS-tech

KOSHIBU PRECISION

3H206

3H205

3H208 3H204

3H209 Felicross

3H203

MIE ELECTRONICS

Smart Film Device Association
PI-CRYSTAL
SOEL
ORGANO CIRCUIT

3H106 AREX

3H104 Quark

3H006 SOUYA

3H005 TOKYO RADAR

3H103

3H102 GYRO

3H101

3H003

3H002 emuni

3H001 FORCIA

CURIO SCHOOL

Jainal Service

Hong Kong Trade
Development Council

2H305 Active Retech

2H304

2H303

2H302 RCL
DISPLAY

2H301

VISUAL
SEMICONDUCTOR

SHENZHEN GUANGZHIBAO TECHNOLOGY

Lefixea

Guangdong Tuqiang electronic Technology

Japan Manned Space Systems

Okura Industrial

WIZAPPLY
Jinan Documents

2H309 2H308

2H310

2H311

2H307

2H306

Xacti

Bicom Aicom

TATSUTA Electric Wire and Cable

Realtek GHLLIA

Semiconductor Japan

2H408 2H407

2H406

2H405 OPTAGE

2H401

bossjob

JiangXi Guide Technology

Nippon Algorithm TOMER&D

China Electronic Exhibition &
Information Communication
Shenzhen Jinghua Displays Electronics
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Shenzhen Grepow Battery
SHENZHEN K-TECH TECHNOLOGY
Nanjing CEC Panda Crystal Technology

Athena Technologies

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Nanjing CEC Panda Crystal Technology

Athena Technologies

STUFF

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2H412

2H411

NEC
Personal Computers

JiangXi Guide Technology

Nippon Algorithm TOMER&D

China Electronic Exhibition &
Information Communication
Shenzhen Jinghua Displays Electronics
Dongguan Glory Mark and
Asia Link Technology
Shenzhen Grepow Battery
SHENZHEN K-TECH TECHNOLOGY
Nanjing CEC Panda Crystal Technology

Athena Technologies

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Fujitsu

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National Institute of Advanced Industrial Science and Technology

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TAIYO YUDEN

TAIYO YUDEN



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MIRAIT ONE Group

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Gijutsu-Hyoron

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Impress

Gicho business communications

1H120

CIAJ and HATS Forum

Communications and Information Network Association of Japan

HATS Forum

CIAJ User Network Systems Committee

NEC Platforms

Oki Electric Industry

Hitachi Information & Telecommunication Engineering

CIAJ Image Data Communications and Facsimile Committee

CIAJ Communications Quality Committee

Telecommunication Technology Committee

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National Institute of Information and Communications Technology (NICT)

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2H212

Yukai Engineering

2H211

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CADDi

Shenzhen Unique Scales

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Shanghai Jingying Electronic Technology

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YES OPTOELECTRONICS(GROUP)

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NTT DOCOMO

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CITIZEN FINEDENCE

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Topre

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JP Tokyo

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Tokyo Metropolitan Government Startup Strategy Promotion Headquarters

inDs HelioX LOOVIC

Japan Institute of Invention and Innovation / Japan Institute for Promoting Invention and Innovation

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JVC KENWOOD

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NISICOM CognitechDEV

Nippon Dempa

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newmo ZREK SolaNika

1H101

Leaner Technologies

Willque (HK) Development

2H102

CaTa aptpod CAD CENTER Cesium LiberaWare MAP IV MODE

2H101

Association of Radio Industries and Businesses

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Saitama University

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1H207

Acompany

Creative Vision

Bureau of Digital Services

Tokyo Metropolitan Government



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6H304 ABeam Consulting Ltd.
4H301-04 ACCEL LAB Ltd.
4H301-11 ACCESS Co. Ltd.
1H207 Acompany Co. Ltd.
5H018 Acompany Co. Ltd.
2H305 Active Retech Inc.
3H211 ADOS-tech
4H004 Advanced Academic Agency
2H406 Aicom Co. Ltd.
4H207 aida innovazione
1H233 A Inc.
4H004 Aioi Nissay Dowa Insurance Co. Ltd.
2H420 AI Samurai Inc.
4H301-01 AISHANOARUKURASHI
5H380 Alsmiley, Inc.
4H110 AIST HCMI Consortium
4H001 ALAN Consociam
5H008 Alarm.com
4H301-04 Allion Japan Inc.
6H201 AlphaDrive
4H301-01 ALSOK Co. Ltd.
1H314 ALTEN Japan Co. Ltd.
5H020 ALTNA Co. Ltd.
2H023 Amaryllo International, Inc.
6H111 ANA HOLDINGS Inc.
3H410 Analog Devices, Inc.
6H007 ANKR DESIGN ink.
4H004 Another works
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5H210 ANRITSU Corp.
4H004 AOI Pro. Inc.
6H014 Aokumo Inc.
6H016 AP Communications
2H102 aptpod, Inc.
4H301-03 Aqara LLC.
4H301-04 Aqara LLC.
3H412 Archelis Inc.
3H412 Area Japan Ltd.
3H106 ARES Inc.
4H001 ARK Inc.
6H147 Aromajoin Corp.
6H290 Artience Lab Inc.
6H222 Artscollege Yokohama
6H143 Arts Japan
6H111 artTunes Co. Ltd.
3H412 ASahi ETIC. Co.
5H020 Asaka Riken Co. Ltd.
5H005 AsiaQuest Co. Ltd.
3H222 a.s.ist Inc.
2H101 Association of Radio Industries and Businesses
3H412 ASTRODESIGN, Inc.
5H020 Asuene Inc.
2H412 Athena Technologies, Inc.
5H020 Automotive and Battery Traceability Center Association, Inc.
3H411-6 AV-Leader Corp.
6H162 Axcreator Inc.

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5H020 BASF TODA Battery Materials LLC.
5H020 Battery Association for Supply Chain
3H602 BHW Technologies Ltd.
2H406 Bicom Inc.
4H001 Bifrötec Inc.
6H015 BizTech, Inc.
4H105 BL Innovare
3H205 Blogwatcher Inc.
5H018 Blogwatcher Inc.
6H240 BLUEISH Inc.
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6H151 Bocek
5H302 BONSAI STUDIO Inc.
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5H390 Cabinet Office, National Space Policy Secretariat/
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5H002 Centillion system
5H020 Central Glass Co. Ltd.
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3H411-13 CHANGING INFORMATION TECHNOLOGY Inc.

6H210 Chiba Institute of Technology
3H513 Chiba Prefectural Police
6H290 Chiba Pref.
2H312 China Electronic Exhibition & Information
Communication Co. Ltd.
1H306 China Kun-Shan Pavilion
6H255 Chubu University Tsukawa Laboratory
6H138 CHUO Institute of Information and Design
5H207 CIAJ All Photonics Network Pavilion
1H120 CIAJ and HATS Forum
1H120 CIAJ Communications Quality Committee
1H120 CIAJ Image Data Communications and Facsimile Committee
1H120 CIAJ User Network Systems Committee
4H207 Cicada Technologies
6H236 CINCA Inc.
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2H209 CITIZEN FINEDEVICE Co. Ltd.
2H319 City of Ishikari, Hokkaido
5H020 CKD Corp.
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5H004 COGNITEE Inc.
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Consortium
1H120 Communications and Information Network
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Association of Japan (CIAJ)
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4H301-12 Connected Consumer Device Security Council
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3H603 Coolish Music Co. Ltd.
6H223 Cooperative Robotics Laboratory, Tokyo Denki
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4H004 CORE Corp.
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6H131 Cosinus Ltd.
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1H209 Creative Vision Ltd.
6H248 CREST ZT-IoT
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2H421 Crystals Technology Ltd.
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6H017 CyberneX Co. Ltd.
4H301-04 Cybertrust Japan Co. Ltd.

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3H222 DENSHI-GIHAN Co. Ltd.
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1H223 Dentsu Lab Tokyo
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6H111 Diphylleia Inc.
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4H207 DLABORATORY Sweden AB
2H312-2 Dongguan Glory Mark and Asia Link Technology Co. Ltd.
5H020 dotD inc.
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3H202 DUAL MOVE Co. Ltd.
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4H004 Dynamic Map Platform Co. Ltd.

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4H301-09 ECHONET Consortium
4H301-13 Edion Corp.
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6H111 Eureka Wireless KK.
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3H411-12 EXPLUS Co. Ltd.
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6H252 Final Aim, Inc.
2H201 Findy Inc.
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3H222 godelblock Inc.
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4H105 Government of Ontario, Ministry of Economic
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5H020 GS Yuasa Corp.
3H411-9 GT CONTACT Co. Ltd.
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4H301-12 Hakuodo Inc.
3H412 Haloworld Inc.
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3H509 HELATH Co. Ltd.
1H105 HelioX Inc.
3H411-2 HIGGSTECH Inc.
6H012 High density thin film device, Innovation Center
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5H018 Hino Computer System Co. Ltd.
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 5H207 Japan Aviation Electronics Industry, Ltd.
 2H202 Japan Display Inc.
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 4H204 Japan Electronics and Information Technology
 Industries Association Semiconductor Board
 Japan federation of electronic parts distributors & dealers
 1H226 Japan Institute of Invention and Innovation /
 Japan Institute for Promoting Invention and Innovation
 JAPAN MACHINERY Co.
 2H311 Japan Manned Space Systems Corp.
 3H205 JAPAN TRAVEL AND TOURISM ASSOCIATION
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 2H308 Jhoson Documents Inc.
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 6H002 JIMED Inc.
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 6H238 Kotozna Inc.
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 Ministry of Land, Infrastructure, Transport and Tourism
 Ministry of Land, Infrastructure, Transport and Tourism
 Ministry of Land Infrastructure Transport and
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 4H301-05 mui Lab, Inc.
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 2H312-8 Nanjing CEC Panda Crystal Technology Corp.
 6H117 NanoSpike, Inc.
 6H135 National Institute of Technology,Tokyo College/
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 College Hirose Campus/TAIKO TRADING Co., Ltd.
 1H325 National Institute of Advanced Industrial Science
 and Technology
 4H110 National Institute of Advanced Industrial Science
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 6H248 National Institute of Informatics/
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 6H220 Nihon University
 3H109 Niigata City
 2H203 nippo
 2H318 Nippon Algorithm Co. Ltd.
 1H215 Nippon Dempa Co. Ltd.
 5H020 Nippon GIJUTSU CENTER Co. Ltd.
 5H020 Nippon Recycle Center Corp.
 5H020 NIPPON SHOKUBAI
 4H004 NIPPON TRAVEL AGENCY Co. Ltd.
 3H222 Nishika, inc.
 1H216 NISICOM Co. Ltd.
 2H419 Nissho Elektron Co., Ltd.
 5H020 Nissin Kogyo Co. Ltd.
 4H301-04 Nordic Semiconductor K.K.
 6H127 Nordic Semiconductor K.K.
 4H035 NOVASELL Inc.
 2H027 NPR-RIKEN Corp.
 6H022 NR-Power Lab
 5H020 NSK Ltd.
 4H110 NS Solutions Corp.
 5H207 NTT, Inc.
 1H007 NTT DOCOMO, Inc.
 4H004 NTT EAST, Inc.
 4H301-01 NTT ExPartner Corp.
 1H303 Numata City, Gunma Pref.
 4H207 NUTAI
 4H204 Nuvoton Technology Corp. Japan
 4H301-04 NXP Semiconductors

O

4H001 Ocean Digital Society Pavillion
 5H207 Oi Electric Co. Ltd.
 1H120 Oki Electric Industry Co. Ltd.
 4H020 Okinawa Resort Workcation Promotion Council
 2H310 Okura Industrial
 6H251 ONIXION
 5H020 OONO DEVELOPMENT Co. Ltd.
 3H205 Opentone Co. Ltd.

3H222 OPI Corp.
 2H405 OPTAGE Inc.
 1H319 OPTO PLUS TECHNOLOGIES Corp.
 6H208 OPTOWL
 3H204 ORGANO CIRCUIT
 4H001 Osakana DAO Nagasaki
 4H004 Osaka Pref. / Osaka City
 6H004 Osaka Sangyo University
 5H020 OSAKA SODA Co. LTD.
 2H111 Ostiaries, Inc.
 3H222 OUTSENSE inc.

P

3H205 PACIFIC CONSULTANTS Co. Ltd.
 3H222 palan, Inc.
 5H020 Panasonic Energy Co. Ltd.
 6H020 Patentfield Ltd.
 5H304 People Corp.
 5H311 PERSOL INNOVATION Co. Ltd.
 6H123 PFU Ltd.
 4H030 PHD Chamber of Commerce and Industry
 4H301-01 Phiten Co. Ltd.
 3H503 PhyDB
 3H204 PI-CRYSTAL Inc.
 3H222 Picto Care Inc.
 3H514 Pionero, Inc.
 6H119 PITTAN Inc.
 5H203 PLAUD Co. Ltd.
 6H155 POLYMERIZE G.K.
 4H105 Pontosense
 3H107 PowerManagement, Ltd.
 5H020 Powrex Corp.
 5H205 Preferred Networks, Inc.
 5H020 Prime Planet Energy & Solutions, Inc.
 6H290 Primesense Co. Ltd.
 5H018 PrivacyTech Inc.

Q

2H016 QD Laser, Inc.
 6H207 Qualiteq Inc.,
 3H104 Quark, Inc.
 2H115 Quectel Wireless Solutions

R

3H306 RainScales Japan
 4H035 RAKSUL
 2H302 RCL DISPLAY Ltd.
 2H408 Realtek Semiconductor Japan Corp.
 4H301-04 Realtek Semiconductor Japan Corp.
 5H010 Rebuff Reality
 4H004 Regional Revitalization 2.0 Special Pavillion
 4H004 Regional Well-Being Indicator Secretariat, Digital Agency
 4H204 Renesas Electronics Corp.
 5H319 Research Coordinate, Inc.
 3H508 Residential Devices Co-Creation Organization
 4H020 ResorTech EXPO 2025 in Okinawa
 5H020 Ricoh Co. Ltd.
 6H022 RICOH Co. Ltd.
 5H016 RIKEN Center for Computational Science
 1H318 Rinnai Corp.
 6H242 Ritsumeikan University / Niigata University
 4H105 River Birch Global Water
 4H213 RNA Co-Creation Consortium
 6H204 Robosensor Technologies, Inc.
 6H290 Rock Giken Kogyo Co. Ltd.
 4H204 ROHM Co. Ltd.

S

1H210 Saitama University
 4H040 Sakaguchi Lab, Institute of Science Tokyo
 4H004 Sakai Moving Service Co. Ltd.
 2H028 SANGYO TIMES Inc.
 4H204 Sanken Electric Co. Ltd.
 5H207 SANKYU ELECTRONICS Corp.
 2H001 Sansan, Inc.
 3H214 SANYO CHEMICAL INDUSTRIES, Ltd.
 5H018 SATO Corp.
 4H301-01 Science Corp.
 3H605 SCraft Inc.
 4H207 Scriptide
 4H020 SCSK Corp.
 4H301-04 SEALSQ
 6H009 Secafy Co. Ltd.
 4H004 Secretariat of the Headquarter for the Creation of New Regional Economies and Living Environments CABINET SECRETARIAT
 4H020 Secure Innovation Inc.
 5H020 Seibu Giken Co. Ltd.
 4H301-12 SEKISUI HOUSE, Ltd.
 4H204 Semiconductor Board
 3H507 SEMITEC
 4H004 SENDAI City
 3H411-8 SFI ELECTRONICS TECHNOLOGY Inc.
 2H205 Shanghai Distributed Artificial Intelligence
 Scholar Technology Co. Ltd.
 1H234 Shanghai Jingying Electronic Technology Co. Ltd.
 4H030 Shants

3H223 SHARP Corp.
 2H312-4 Shenzhen Grepow Battery Co. Ltd.
 2H303 SHENZHEN GUANGZHIBAO TECHNOLOGY Co. Ltd.
 2H312-1 Shenzhen Jinghua Displays Electronics Co. Ltd.
 2H312-6 SHENZHEN K-TECH TECHNOLOGY Co. Ltd.
 2H125 Shenzhen Unique Scales Co. Ltd.
 5H020 SHIBAURA MACHINE Co. Ltd.
 5H020 Shimadzu Corp.
 5H316 Shonan Institute of Technology
 3H411-17 SIC TECHNOLOGY Co. Ltd.
 4H301-04 Silicon Labs
 2H415 Sinumy Corp.
 6H113 Sionix AI Inc.
 3H218 SI Synergy Technology Co. Ltd.
 6H153 SK Fine Co. Ltd.
 4H004 SMART CITY SOCIAL IMPLEMENTATION CONSORTIUM
 3H204 Smart Film Device Association
 5H020 SMC Corp.
 6H166 Smoothie Studio Co. Ltd.
 3H204 SOEL
 5H018 SoftBank Corp.
 4H105 Solace Systems
 1H102 SolaNika Co. Ltd.
 2H307 SOLIDRAY Co. Ltd.
 3H222 SolvifAI Inc.
 4H115 Sompoo Japan Insurance Inc.
 5H020 Sompoo Light Vortex, Inc.
 3H222 SONAS, Inc.
 3H412 Sonas, Inc.
 6H303 Sony Group Corp.
 4H204 Sony Semiconductor Solutions Corp.
 3H006 SOUYA Co. Ltd.
 6H111 SpaciaNet Japan Inc.
 4H207 Sparsity Technologies
 2H324 Speeda
 5H201 Speeda
 6H149 Stayway Inc.
 6H114 STEALIEN Inc.
 1H317 Stockmark Inc.
 6H159 studio boken inc.
 2H413 STUFF Co. Ltd.
 5H301 SUGINO EICHI Corp.
 6H132 SuhyunTech Co. Ltd.
 2H208 Sumitomo Bakelite Co. Ltd.
 3H217 Sumitomo Metal Mining Co. Ltd.
 5H020 Sumitomo Metal Mining Co. Ltd.
 5H020 Sumitomo Riko Co. Ltd.
 3H411-15 SUNCA Co. Ltd.
 1H103 SUNPLANSOFT Co. Ltd.
 3H411-11 SUPERIOR TECH Co. Ltd.
 5H304 Sustinere Co. Ltd.
 5H020 SUZUKI Co. Ltd.
 4H301-04 SwitchBot JP Co. Ltd.

T

5H003 T2 Laboratory Corp.
 3H222 Tada Plastic Industries Co. Ltd.
 5H020 Taikisha Ltd.
 3H411-4 TAIWAN ALPHA ELECTRONIC Co. Ltd.
 3H411-3 Taiwan Electrical and Electronic Manufacturers' Association
 1H121 TAIYO YUDEN Co. Ltd.
 5H018 TAKENAKA Corp.
 5H020 TAKIGEN MFG. Co. Ltd.
 5H304 TAKIZAWA CITY
 5H304 TakizawaRoboticsLLC.
 5H313 Tamagawa University
 5H020 TANABE Corp.
 2H309 TATSUTA Electric Wire and Cable Co. Ltd.
 6H180 TDK Corp.
 2H104 TechnoCore Inc.
 5H007 Techtical Inc.
 5H370 Techtouch, Inc.
 1H120 Telecommunication Technology Committee
 4H301-01 TEPCO Energy Partner, Inc.
 2H126 TERAMOTO
 3H411-5 T-GLOBAL TECHNOLOGY Co. Ltd.
 6H224 The University of Tokyo / Keio University / Shizuoka University (D3-AI Project)
 5H006 Tigris Systems
 4H210 TODA Corp.
 1H228 TOKI Trading Ltd.
 1H105 Tokyo Metropolitan Government Startup Strategy Promotion Headquarters
 3H412 TOKYO METROPOLITAN INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
 3H222 Tokyo Metropolitan Small and Medium Enterprise Support Center(Tokyo Business Frontier)
 3H005 TOKYO RADAR Corp.
 5H020 TOKYO SEIMITSU Co. Ltd.
 3H502 Tokyo University of Information Sciences
 5H325 Tokyo University of Technology
 2H317 TOME R&D Inc.
 6H146 TopoLogic Inc.
 4H301-04 TOPPAN Digital Inc.
 2H118 Topre
 4H204 Toshiba Electronic Devices & Storage Corp.
 5H020 Toshin Co. Ltd.
 5H322 TouchStar
 3H205 Tourism Forecast Platform Promotion Team
 3H304 Toyama Pref.
 5H020 TOYOTA BATTERY Co. Ltd.

3H504 TOYOTA MOTOR Corp.
 Heat Flux Sensor "Energy flow"
 Toyota Technical Development Corp.
 3H512 Toyota Tsusho Corp.
 5H020 TOYOTA TSUSHO MATERIAL Inc.
 1H312 Trans AI
 1H229 TRANSTOUCH TECHNOLOGY INC. (tti)
 3H216 Trenger Technology Solutions Pvt Ltd.
 6H290 TSUBASA FRONTIER Co. Ltd.
 5H020 Tsukushima Kikai Co. Ltd.
 4H004 Tsukuba City
 4H301-04 TÜV Rheinland Japan Ltd.
 5H324 TWOFOUR DESIGN WORKS LLC.

U

4H030 UCCJ - Ukrainian Chamber of Commerce in Japan
 4H030 Ukraine IT Pavillion
 4H030 Ukraine Pavillion
 2H016 Ultimems, Inc.
 5H018 unerry, Inc.
 6H201 UNIDIGE
 4H301-12 UNIVERSITY OF THE RYUKYUS
 4H001 UNIVERSITY OF THE RYUKYUS (BLUE&GREEN REVOLUTION)
 3H412 Upside LLC.
 4H030 Uzbekistan Pavillion

V

2H011 Valerion
 3H010 VALUENEX Japan Inc.
 4H030 Variphi Gen Innovation Private
 6H115 VCAT AI Corp.
 2H119 VCCI Council
 2H024 VisasQ Inc.
 2H301 VISUAL SEMICONDUCTOR, Inc.
 6H161 ViXion, Inc.
 6H228 VMFi Inc.
 3H213 VRC Inc.
 3H412 VR Design Institute Inc.
 4H020 vvlnd Inc.

W

6H013 WeGlobal Inc.
 2H211 Wei Ken Electrical And Circuit Ltd.
 6H290 WellMent Co. Ltd.
 6H127 WhiteLab
 2H010 Willque (HK) Development Ltd.
 3H412 wing robotics, Inc.
 2H308 WIZAPPLY Co., Ltd.
 3H222 woodinfo partners
 6H290 Work Robotics Co. Ltd.
 3H406 Wovn Technologies, Inc.
 2H110 Wuxi Lineprinting Materials Co., Ltd.

X

2H306 Xacti Corp.
 4H301-04 X-HEMISTRY Inc.

Y

4H301-01 YAMADA DENKI Co. Ltd./YAMADA HOMES Co. Ltd.
 6H011 Yamagata University Innovation Center for Organic Electronics Flexible Electronics
 6H010 Yamagata University, INOEL, Organic & Next Generation Solar Cell Division
 5H020 Yamaha Motor Co. Ltd.
 5H020 YASKAWA Electric Corp.
 5H018 Yazaki Corp.
 2H321 YEEBO DISPLAY Ltd., TAIWAN BRANCH (H.K.)
 1H231 YES OPTOELECTRONICS(GROUP) Co. Ltd.
 5H020 Yodogawa Hu-Tech Co. Ltd.
 6H254 Yokohama National University
 3H308 Yokowo Co. Ltd.
 6H290 Yoshino Machinery Co. Ltd.
 3H511 YSL Solution, Co. Ltd.
 2H212 Yukai Engineering Inc.

Z

3H215 Zenken Corp.
 5H018 ZENRIN Co. Ltd.
 5H018 ZENRIN DataCom Co. Ltd.
 6H148 ZeroOne Inc.
 6H234 Zero To One Lab Inc.
 6H202 Zeteh, Inc.
 3H222 Zettant Inc.
 1H102 ZREK Inc.

1-9

6H111 01Booster Inc.
 6H111 01Booster Capital Inc.
 5H207 1Finity Inc.
 2H026 346 Inc.
 6H157 3D Inc.

Events

Opening Reception / CEATEC AWARD Ceremony

The Opening Reception took place on 6:30PM-8:30PM, Oct 14th, at the Palace Hotel Tokyo. A video message from Prime Minister Shigeru Ishiba was presented, followed by congratulatory remarks from distinguished guests including Masaaki Taira (Minister for Digital Affairs), Yuichiro Koga (Vice Minister of Economy, Trade and Industry), and Hideto Kawasaki (Parliamentary Vice-Minister for Internal Affairs and Communications). Approximately 700 attendees — including executives from exhibiting companies, embassy officials, and government representatives — joined the event and engaged in active networking.

During the reception, the Digital Minister's Award, Minister of Economy, Trade and Industry Award, and Minister for Internal Affairs and Communications Award were officially presented, marking a prestigious start to CEATEC.

Date & Time October 14 (Tue), 18:30-20:30

Venue Palace Hotel Tokyo

■ Opening Reception Program ((Titles are as of the event date.))

- Opening Remarks Kei Uruma, Chair, Chairperson, JEITA
- Video Message Shigeru Ishiba, Prime Minister of Japan
- Congratulatory Address & CEATEC AWARD Digital Minister's Award Presentation
..... Masaaki Taira, Minister for Digital Agency
- Congratulatory Address & CEATEC AWARD METI Minister's Award Presentation
..... Yuichiro Koga, Vice Minister of Economy, Trade and Industry
- Congratulatory Address & CEATEC AWARD MIC Minister's Award Presentation
..... Hideto Kawasaki, Parliamentary Vice-Minister for Internal Affairs and Communications
- Toast & Remarks Toshiaki Higashihara, Vice Chair, Keidanren



Exhibitor Networking Event

After the general exhibition closed on October 15 (Wed), an Exhibitor Networking Event was held at the AX Stage inside the exhibition hall.

More than 200 participants (110 companies/organizations) attended, exchanging ideas and building new connections.

The program also included the CEATEC AWARD Category Awards and Eco & Design Challenge recognition, contributing to industry-wide collaboration and knowledge sharing.

Date & Time 6PM-7PM, Oct 15th

Venue AX Stage, inside the exhibition hall

■ Program

- CEATEC AWARD 2025 Category Awards
- Eco & Design Challenge Awards



CEATEC for Students

CEATEC actively promotes student attendance to support next-generation talent development and to deepen understanding of the technology industry.

At the venue, exhibiting companies were encouraged to welcome students by:

- Providing student-friendly informational materials
- Assigning staff who could explain exhibits in accessible terms
- Displaying the "Student-Friendly Logo" at participating booths

Prior to the event, CEATEC shared information on student-welcoming exhibitors through the official website and venue signage, allowing students and educational institutions to plan efficient visits.

As a result, 95 exhibitors registered for the program, and more than 8,000 students attended CEATEC 2025.

The initiative was highly praised for contributing to talent development, industry-academia collaboration, and future workforce engagement.



Conference

Conference 10/14

CEATEC Opening Session

10:00 - 11:45

HB-11

Convention Hall B

Opening Ceremony & Opening Session 1 The AI Agent Industrial Revolution: Unlocking Japan's Potential

Opening Remarks from CEATEC Organizer



Chairperson of JEITA
Mr. Kei Uruma

Panel discussion



CEO
Gen-AX Corp.
Mr. Shinichiro Isago



Japan Commercial Head
Uber AI Solutions
Mr. Aya Zook



CEO
Salamander Inc
Mr. Daiki Sakurai



Executive Officer
Uhuru Corporation
Mr. Masahiro Tanaka

13:00 - 14:30

HB-14

Convention Hall B

Opening Ceremony & Opening Session 2 Towards the realization of a sustainable society



Director, President and
Representative Executive
Officer
Honda Motor Co., Ltd.
Mr. Toshihiro Mibe



Chief Operating Officer
newmo, Inc.
Ms. Haruna Nochi



President & CEO
Mitsubishi Electric Corporation
Mr. Kei Uruma



Founder&CEO
Fermenstation Co., Ltd.
Ms. Lina Sakai



Representative Director &
CEO
Elephantech Inc.
Mr. Shinya Shimizu



Moderator
Ms. Asuka Sakuma

15:00 - 16:30

HB-16

Convention Hall B

Opening Ceremony & Opening Session 3 Regional Revitalization 2.0: A Strong Economy, Affluent Living Environments, A new and enjoyable Japan

Keynote speech



CABINET SECRETARIAT
Mr. Satoshi Ebihara



Digital Agency
Mr. Tomohiro Okada

Panel discussion



Ministry of internal affairs and
communications
Mr. Kaoru Onda



The Graduate School of
Project Design
Ms. Risa Tanaka



Ministry of Economy, Trade
and Industry
Mr. Iwao Miyamoto



CABINET SECRETARIAT
Ms. Rikako Kishida



Ministry of Land,
Infrastructure, Transport and
Tourism
Mr. Takuro Kasao

10:30 - 11:30

HA-11

Convention Hall A

Shaping the Future of the Mobility Industry: DX Strategies, SDV Innovation, and New Experiential Value



Director, Mobility Digital
Transformation Office,
Automobile Division,
Manufacturing Industries Bureau
Ministry of Economy, Trade and
Industry (METI)
Mr. Makoto Kuroyabu



Mobility Business Development
CRI Middleware Co., Ltd.
Mr. Fumihito Kondo



Fellow, Software Development
Center
TOYOTA MOTOR
CORPORATION
Mr. Kenichi Murata



Future Tech-Value Innovation
Strategy Unit Manager
ABeam consulting Ltd.
Mr. Naoki Sekine

12:00 - 13:00

HA-13

Convention Hall A

Regional Revitalization 2.0 Led by Digital Transformation: Learning from Leading Cases



Director-General for Public
Service Group
Digital Agency
Mr. Akira Miura



Japan CDO Community Core
Member
Code for Japan Founder
Mr. Haruyuki Seki



Vice Governor and CDO
Ishikawa Prefecture
Mr. Daisuke Asano



Former Chief Digital Officer (CDO),
Mie Prefecture / Japan CDO
Community Core Member
Chairperson, ulula Inc.
Mr. Junichi Tanaka



President and CEO, Sony Computer
Science Laboratories Inc
Okinawa Institute of Science and
Technology, Professor
Mr. Hiroaki Kitano



Executive Advisor, The Association
for Promotion of Public Local
Information and Communication
Representative, Japan CDO
Community
Ms. Makiko Yoshida

13:30 - 14:30

HA-14

Convention Hall A

The Harmony of Co-Creation and Technology: Challenging "Harmony Between Humanity and Nature" ~ The Future of AI Utilization Envisioned by Kanadevia ~



Representative Director President
& Chief Executive Officer
Kanadevia Corporation
Mr. Michi Kuwahara



Partner of Technology&Digital
Consulting
PwC Consulting LLC
Mr. Shingo Arai



Director & Managing Executive Officer
General Manager Information and
Communication Technology Promotion
Headquarters
Kanadevia Corporation
Mr. Munenobu Hashizume



Director of Technology&Digital
Consulting
PwC Consulting LLC
Mr. Hiroshi Kihara

15:00 - 16:30

HA-16

Convention Hall A

The Future of All Photonics Networks Supporting Digital Infrastructure in the AI era



Editor-in-Chief, Nikkei Business
LIVE
Nikkei Business Publications
Mr. Isao Horikoshi



SVP, Head of Photonics
System Business Unit
iFINITY Inc.
Mr. Hideki Matsui



Ministry of Internal Affairs and
Communications
Mr. Masayuki Matsui



NexGen Social Infrastructure
Promotion Office Senior Director
SoftBank Corporation
Mr. Kunimitsu Asanuma



Founder & CEO, President
SAKURA internet Inc.
Mr. Kunihiro Tanaka



Corporate Distinguished Engineer Sr.
Director, Head of Lund Technology
Laboratory · IOWN Global Forum
Use Case Working Group Chair
Sony Corporation
Mr. Katsutoshi Ito

Conference Online

Publication period: 10/01 13:00 - 10/31 17:00

ON-2 Green x Digital Consortium
Special ConferenceUnlocking
New Corporate Value through
Environmental Activity Data

ON-3 Market Forecast: Data-less
Client and Competitive Products

ON-4 Human Resources Symposium
for Semiconductor Industry(JEITA
Semiconductor Forum 2025)

ON-5 Next Generation Human
Resources Crosstalk

ON-6 HATS conference 2025

ON-7 The forefront of web
accessibility

ON-8 Improving accessibility through
inclusive design

ON-9 AI Application Frontline Part3
"DX Practical Examples of JEITA
Member Companies" ~Technology
Strategy Steering Board Conference~

ON-11 European Trends and Case
Studies in the Circular Economy

ON-12 Electronic Components
Technology Roadmap to 2035: Trends
in Electronic Components Enabling the
Smart Cities of Society 5.0

ON-13 A Must-See for Students! The
World of Electronic Components

ON-14 IT Trend Survey ~the front line
of IT Platforms Supporting Digital
Management-Generative AI, Cloud,
Green IT~

ON-15 Next-generation innovation driven by AI

ON-16 European Digital Champions:
Solutions in Action

ON-17 Million eyes in one moment:
Transforming Infrastructure and
Industry with AI Vision

ON-18 Mikrotik's SIA/MikroTik

ON-19 Shants Inc., and Ukrainian tech
cluster Brave1

ON-21 Introduction of Dentsu BX
Creative center "R&D&C"

Room 201 (R2), 2F International Conference Hall	Room 301 (R3), 3F International Conference Hall	E Stage in Exhibition Hall 6(ES)	T Stage in Exhibition Hall 4(TS)	AX Stage in Exhibition Hall 5 (AS)	NGP Stage in Exhibition Hall 6 (NS)
10:30 - 11:30 R2-11 What Makes the Electronics Components Industry Shine?	10:30 - 13:00 R3-11 The Challenge of Building an AI × Dataspace Society	10:30 - 11:30 ES-11 Learning from Advanced European Cases: Data Security for Further Data Utilization	10:30 - 11:10 TS-11 Shuri Castle × DX — Okinawa' s Challenge to Connect Tradition with the Future —	10:30 - 11:30 AS-11 The Reality of DX Support: AI and Human Resource Development from the DX Acceleration Local Lab	10:30 - 11:30 NS-11 Dialogue with Innovators Pioneering the Future: Pitch and Talk Session at the 10th JEITA Venture Awards
12:00 - 13:00 R2-13 Transforming Audio Accessibility in Public Spaces with Auracast™		12:00 - 13:00 ES-13 Key to Successful New Businesses in Large Corporations and How to Utilize New Human Resources - Practical Knowledge from an Active Business Manager.	11:30 - 12:10 TS-12 Initiatives for Industrial Data Collaboration toward Solving Social Issues and Achieving Economic Development ~ Toward a Sustainable Society and Future- Oriented Urban Development ~		11:45 - 12:45 NS-12 Global Startups Take on Japan' s Sustainable Market
			12:30 - 13:10 TS-13 Innovation in the marine business through cross-industry collaboration powered by Aqua Local Area Network (ALAN) Consortium.	13:00 - 13:30 AS-14 Multi-AI Agents Lead to "Data Democratization 2.0" - Breaking down data silos and creating a world where AI operates autonomously -	13:00 - 14:00 NS-14 Before Collaboration Begins : Key Early-Stage Insights from 2024 Case Studies
13:30 - 14:30 R2-14 Generate Verified, Hardware-Ready Code with Provable AI R2-14	13:30 - 14:30 R3-14 Factory Security Measures Development Guidelines and Tool Utilization Workshop -Would you like to try developing factory security measures?-	13:30 - 14:30 ES-14 The future opened up by theQuasi-Zenith Satellite System "Michibiki" and the forefront of its utilization	13:30 - 14:00 TS-14 Building Bridges: From Ukraine' s Tech Clusters to Japan' s Industrial Ecosystem		
			14:00 - 14:30 TS-15 Unlocking Uzbekistan' s IT Potential: Building a Digital Bridge Between Uzbekistan and Japan	14:00 - 14:30 AS-15 AI is transforming meeting minutes. Boost your productivity with Plaud AI.	14:15 - 15:15 NS-15 Deep Tech VCs discuss how to engage with University- Spun-Off startups in a period of turbulent transformation
15:00 - 16:00 R2-16 Human Centric Manufacturing and the use of AI and robots	15:00 - 16:00 R3-16 Profit Center' - Automation. Acceleration. Innovation		14:40 - 15:10 TS-16 Forefront of Indian IT Business	15:00 - 15:30 AS-16 Introducing Our SaaS Platform for Integrated Security and Wellness Solutions (Alarm.com)	
			15:30 - 17:00 TS-17 JC-STAR × Consumer Market: Transforming Security into Value	16:00 - 16:30 AS-17 Generating Verified, Hardware-Ready Code Using Provable AI	15:30 - 17:00 NS-16 Next Entre 2025 Student Pitch Contest
16:15 - 17:00 R2-17 Idea Generation for Sparkling Innovation in the AI Era: Human Imagination Fuels Passion					

Pitch Stage in Exhibition Hall 5 (PS)

PS-12

Next-Generation Patent Search
and Analysis with Generative AI!
Introducing Patentfield

PS-141

Challenge to develop Japan's first
implantable BCI medical device

PS-142

Introduction to Digital Technologies
Developed by JAEA

PS-143

Network packet never says a lie

PS-144

Edge: A New Business Creation Support
Service by TV Broadcasters and
Startups

PS-151

Optimizing Daily Life and Cities with
Sheet-Type Multifunctional Sensors
that Continuously and Subtly Detect
Invisible Micro Changes, Contributing
to Smart and Sustainable Urban
Development

PS-152

Optical Design Assistant for Eliminating
Reliance on Individual Expertise

PS-153

The Progress of Generative AI in Design
and Related IP Risks

PS-154

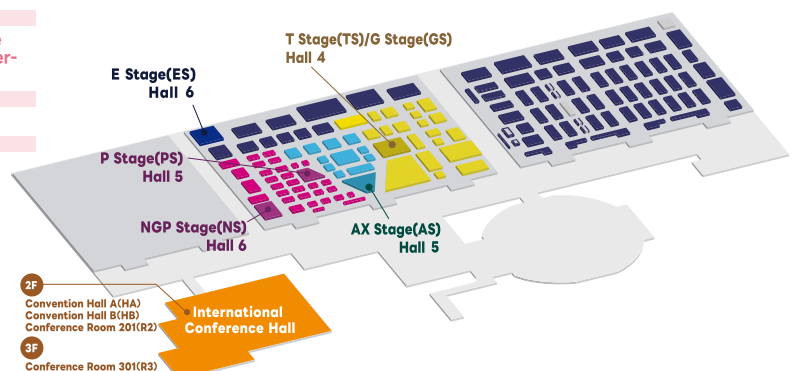
In-motion charging of EVs using the
world's smallest antenna and marker-
based autonomous driving

PS-16

VMFi Inc.

PS-161

Is robot a key for solving labor
shortages?



Conference 10/15

10:00 - 12:00

HB-21

Convention Hall B

Unlocking Our Future with Data and AI Part I: Shaping a New Era of Our Society and Industry with a Digital Ecosystem Part II: Building the Digital Ecosystem of the Future

Unlocking Our Future with Data and AI: Part I "Shaping a New Era of Our Society and Industry with a Digital Ecosystem"



Commissioner, Information-technology Promotion Agency and President, Digital Architecture Design Center (DADC)
Information-technology Promotion Agency, Japan (IPA)
Mr. Yutaka Saito

Unlocking Our Future with Data and AI: Part II "Building the Digital Ecosystem of the Future"



Director General of Digital Infrastructure Center and Deputy Executive Director and Secretary G
Information-technology Promotion Agency, Japan (IPA)
Mr. Kenji Hiramoto

12:30 - 14:00

HB-23

Convention Hall B

The Future of Smart Living in the Era of Smart Home 2.0



CEO
Connectivity Standards Alliance
Mr. Tobin Richardson



HOMETACT Project Manager
Mitsubishi Estate Co., LTD.
Mr. Yoshi Tachibana



Professor
Advanced Collaborative Research Organization for Smart Society (ACROSS)
Mr. Hideo Ishii



Director/CTO
ACCEL LAB Ltd.
Mr. Tsugutaka Aoki



Research & Development Division Director
MIWA LOCK Co., LTD.
Mr. Takuo Kinoshita



CEO
X-HEMISTRY Inc.
Chair, Connectivity Standards Alliance Japan Interest Group
Mr. Fumi Shingai

14:30 - 15:30

HB-25

Convention Hall B

Co-Creation with RNA Technology: Shaping the Future of Living -Beauty, Health and Beyond



Manager, Skin Care Products Research
Kao Corporation
Mr. Sho Kikuchi



Senior Manager, Health Science Business Division
Kirin Holdings Company, Limited
Mr. Yusuke Ushida



Senior Executive Officer, CSO and Head of Corporate Strategy Office
istyle inc.
Mr. Kensaku Hamada

16:00 - 17:00

HB-27

Convention Hall B

Challenges and Future Outlook for Building Industrial Data Spaces



Director for Policy Planning, Data Strategy Division, Strategy and Organization Group Digital Agency Japan Digital Ecosystem Partnership Policy Planning & Steering Committee
Data Strategy and the Initiatives by the Digital Agency
Mr. Hiroki Yoshida



Carbon data visualization project leader
Green x Digital Consortium (NEC Corporation)
Framework and data integration for visualization of CO2 data across the entire supply chain
Mr. Koichi Inagaki



Chairperson
Automotive and Battery Traceability Center Association, Inc. (ABtC)
Data sharing service across automotive and battery industries of the Ouranos Ecosystem
Mr. Teruyoshi Fujiwara



Member, Working Group on Industrial Data Spaces, Keidanren (Hitachi, Ltd.)
Japan Digital Ecosystem Partnership Policy Planning & Steering Committee
Robot Revolution & Industrial IoT Initiative (RRI) WG1 Co-chair person
Initiatives to create use cases utilizing industrial data spaces
Mr. Naohiko Irie



co-leader
CMP-TF (Canon Inc.)
Development status of CMP (Chemical and Circular Management Platform) and Recycling Management Information Platform (RMP) concept
Mr. Kiyoto Furuta

10:00 - 12:45

HA-21

Convention Hall A

5G/6G Special Day II Day 1 —Evolution and Development of 5G/Local 5G— Session 1 ~ The State and Outlook of 5G Domestically and Abroad ~



Director-General of the Telecommunications Bureau
Ministry of Internal Affairs and Communications, Japan (MIC)
Mr. Hironobu Yumoto



Executive Vice President & CTO
SoftBank Corp.
Mr. Hideyuki Tsukuda

NTT DOCOMO's 5G: Present, and Future



Senior Vice President
Executive General Manager of Network Division
NTT DOCOMO, INC.
Mr. Akihiro Hikuma

5G Deployment at KDDI – Current Status and Future Outlook



Senior Managing Executive Officer, CTO and General Manager, Core Technology Sector
KDDI Corporation
Mr. Kazuyuki Yoshimura

1Finity's Journey: From Enterprise Origins to Global Horizon



Corporate Executive Officer, COO
1Finity Inc.
Mr. Shingo Mizuno

The State of Infrastructure Sharing and Its Outlook: Global Trends and the Japan Model



Senior Executive Officer
Sharing Design Inc.
Mr. Yuji Kamimai

5G Deployment Status and Future Outlook



Executive Officer, Director, Advanced Technology Engineering Supervisory Department
Rakuten Mobile, Inc.
Mr. Ryoji Osaka

5G/6G Networks for an AI-Native Society



Corporate Executive Vice President (Executive Officer), President of Telecom Services Business Unit
NEC Corporation
Mr. Michio Kiuchi

Closing



Professor
XGMF Co-Chair, The University of Tokyo
Mr. Hiroyuki Morikawa

13:30 - 15:15

HA-24

Convention Hall A

5G/6G Special Day II Day 1 —Evolution and Development of 5G/Local 5G— Session 2 ~ Advancing Industrial DX with 5G/Local 5G ~



NTT EAST, Inc.
Mr. Daishi Mashiyama



Metropolitan Expressway Co., Ltd.
Mr. Toshihiro Oyama



KDDI Engineering Corporation
Mr. Hiroshi Sakamoto



Railway Technical Research Institute
Mr. Kazuki Nakamura



OBAYASHI CORPORATION
Mr. Shoichi Nishi



Regional BWA Promotion Association
Mr. Mitsunori Nakamura



NS Solutions Corporation
Mr. Masayuki Iida



Nokia Solutions and Networks Japan Corp.
Ms. Yoko Nabatame



Kyushu Electric Power Company, Incorporated
Mr. Makoto Watanabe



KYOCERA Mirai Envision Co., Ltd.
Mr. Tohru Kenmotsu



HIROSHIMA GAS Co., Ltd.
Mr. Hideshi Kohno



Mr. Hiroshi Takezawa



NTT DOCOMO BUSINESS, INC.
Mr. Yuki Kinno

15:30 - 17:00

HA-25

Convention Hall A

5G/6G Special Day II Day 1 —Evolution and Development of 5G/Local 5G— Session 3 ~ Further development of 5G with mmWave ~

Session Description



ODAIBA IX Core Project Co-Sub-leader Qualcomm Japan
XG Mobile Promotion Forum
Mr. Masakazu Shiota



semiDAS™ mmWave Ready Distributed Antenna System

Wireless System Dept., Information Network R & D Center Senior Assistant General Manager
Sumitomo Electric Industries, Ltd.
Mr. Hiroshi Miyata



XGMF ODAIBA IX Core Project: Initiatives toward mmW

ODAIBA IX Core Project Co-Sub-leader Qualcomm Japan
XG Mobile Promotion Forum
Mr. Masakazu Shiota



Frontiers of millimeter wave utilization by innovative wireless relay technology

Advanced Technology Development Department, Core Technology Sector
General Manager
KDDI CORPORATION
Mr. Yoshitaka Inoue



Fan Culture x Millimeter Wave: Lessons and Possibilities from Trial and Error

Supporting one's love x 5G Project Leader Murata Manufacturing Co., Ltd.
Next Gen. Telecommunication Business Development Office Network Technology Development Department Corporate Technology & Business Development Unit Principal Engineer
XG Mobile Promotion Forum
Mr. Daijiro Yoshii



Impressive experiences created with mmWave

Spectrum Planning Office
Corporate Strategy & Planning Department
NTT DOCOMO, INC.
Mr. Eiji Hanawa



Electromagnetic wave control materials

Materials Integration Laboratories Sub-Leader
AGC Inc.
Mr. Osamu Kagaya



Ms. Mariko Kihara

Room 201 (R2), 2F International Conference Hall	Room 301 (R3), 3F International Conference Hall	E Stage in Exhibition Hall 6(ES)	T Stage in Exhibition Hall 4(TS)	AX Stage in Exhibition Hall 5 (AS)	NGP Stage in Exhibition Hall 6 (NS)
10:30 - 11:30 R2-21 At the Forefront of the Ouranos Ecosystem: Development and Societal Implementation of Interoperable Dataspaces	10:30 - 11:30 R3-21 Examination of technological transformation to next- generation embedded systems development	10:30 - 10:55 ES-21 Utilizing people flow data to solve local issues 11:00 - 11:25 ES-221 The Future of Behavioral Change, Map x Weather DX Achieving Sustainable Logistics, Precise Marketing, and Enhanced Tourist Experiences	10:30 - 11:10 TS-21 - Bringing people's abilities to economic growth - International Standards and Domestic De- facto Standards Promotion Activities and Case Studies	10:30 - 11:00 AS-21 Trends Surrounding Generative AI and PFN's Approach to Societal Implementation of Its Domestic Foundation Model PLaMo	10:30 - 11:30 NS-21 Region x Intellectual Property x SPIN X: Transforming Latent IP and Technology into Regional GDP
		11:30 - 11:55 ES-222 Data-Driven Transformation of Next-Generation Urban Development and Decision-Making	11:30 - 12:10 TS-22 Next generation residence that leverages entrusted lifestyle data to generate intangible value.	11:30 - 12:00 AS-22 Latest Use Cases of Generative AI / AI Agents in Manufacturing and Practical Implementation Strategies	11:45 - 12:45 NS-22 CEATEC 2025 Global Startup Pitch & Networking Event
12:00 - 13:00 R2-23 How to turn amazing technology into marketable one with creativity of dentsu "R&D&C"	12:00 - 13:00 R3-23 Current Status of Generative AI Utilization and Business Applications	12:00 - 12:25 ES-231 Unlocking the Potential of Location Data Business 12:30 - 12:55 ES-232 The Future of Regional Development, Driven by Location Big Data	12:30 - 13:10 TS-23 UI/UX approach and examples of LIXIL's smart home app		
		13:00 - 13:25 ES-241 Gaining a Competitive Edge in Trade Area Analysis with Human flow Data and GIS 13:30 - 13:55 ES-242 AI-Powered Transformation in Japan: Breaking Through Barriers with Real- World Enterprise Strategies	13:30 - 14:10 TS-24 Semiconductor Open Curriculum for students	13:00 - 13:35 AS-241 RIKEN's Pioneering Efforts in "AI for Science": When AI Meets Engineering Design: Controlling Its Creativity in Automotive Aerodynamics 13:45 - 14:20 AS-242 RIKEN's Pioneering Efforts in "AI for Science": Enhancement of analytical capabilities by supercomputer Fugaku ~ Using earthquake problems as examples ~	13:00 - 14:00 NS-24 Shaping the Future of Japanese Open Innovation: Lessons from Aichi's Cross-Border Collaborations
13:30 - 14:30 R2-24 Deeper Dive - Generating Verified, Hardware-Ready Code Using Provable AI		14:00 - 14:25 ES-251 A Digital Twin for Citizens Utilizing Real-Time Flow of People and Geospatial Information 14:30 - 14:55 ES-252 The Future Unlocked by Generative AI x Geospatial Information	14:30 - 15:10 TS-25 The update Trends in Healthcare AI and Digital Transformation Supporting the Super Aging Society	14:30 - 15:05 AS-25 RIKEN's Pioneering Efforts in "AI for Science": The Future of Data-Driven Drug Discovery Powered by AI/DX 15:15 - 15:50 AS-26 RIKEN's Pioneering Efforts in "AI for Science": AI for Science Foundation Model for FugakuNEXT	14:15 - 15:15 NS-25 An Overview of New Business Management: Explaining Roadmaps for Business Model Transformation in Large Enterprises
15:00 - 16:00 R2-26 Driving Innovation in Workforce Development with Virtual Training	15:00 - 16:00 R3-26 Learning and Utilization of Generative AI in Educational Settings: Opportunities and Challenges	15:00 - 15:25 ES-261 Key Issues in AI Adoption in Japanese Companies: How Should We Navigate the AI Era? 15:30 - 15:55 ES-262 How Truck Data Reveals the Current State of Logistics and the Future of Data Utilization	15:30 - 17:00 TS-26 Semiconductor Human Resource Development Academia Session		15:30 - 17:00 NS-26 Technology-Driven Regional Industries: Local Government Collaboration Needs Pitch & Innovation Forum

Pitch Stage in Exhibition Hall 5 (PS)

PS-221

High-Density Nanodot Formation
Technology Using Nanosecond
Ultraviolet Lasers and Its
Application to High-Efficiency
Silicon Solar Cells

PS-222

Robot Technology for Medical
Engineering Collaboration

PS-24

Next-Generation Patent Search
and Analysis with Generative AI!
Introducing Patentfield

PS-242

Accelerating Business with Ready-
to-Work Talent!" High-Class Side Job
Talent Matching Service "lotsful"

PS-25

BONSAI STUDIO broadcasts the value
of emerging technology through video
production; expands video production
workflows with technology.

PS-251

Development of Opto's Meta-Lens

PS-253

AxWorks - A Team Accelerating Video
Production with AI

PS-26

Game-Changing Approaches to
Deploying EV Charging Infrastructure

Global Stage in Exhibition Hall 4 (GS)

GS-24

Canada, Ontario Pavilion Pitch :From AI
to Sustainability

GS-26

Indian Pavilion Pitch: Innovation from
India.



Conference 10/16

10:00 - 12:00

HB-31

Convention Hall B

Pushing the Frontiers of Next-Generation Computing: RIKEN's Challenge to Expand the Limits of Computational Possibility



Next-Generation HPC
Infrastructure Development
Division/Division Director
RIKEN Center for
Computational Science
Dr.Masaki Kondo



Large-Scale Digital Twin
Research Team/Team Principal
RIKEN Center for
Computational Science
Dr.Hirozumi Yamaguchi



Fujitsu Research/Executive
Director
Fujitsu Limited
Mr.Toshio Yoshida



Quantum-HPC Hybrid Platform
Division/Division Director
RIKEN Center for
Computational Science
Dr.Mitsuhsa Sato



Enterprise/Senior Director
NVIDIA GK.
Mr.Izaki Takaeshi



Center for Quantum
Information and Quantum
Biology/Associate Professor
The University of Osaka
Dr.Hiroshi Ueda



Next-Generation HPC
Infrastructure Development
Division Next-Generation HPC
Application Development Unit/
Unit Leader
RIKEN Center for
Computational Science
Dr.Yasumichi Aoki

13:30 - 14:30

HB-34

Convention Hall B

The Power of Diversity : The Actions that lead to Innovation



CEO
Deportare Partners
Mr.Dai Tamesue



Member of the Board,
Executive Vice President Head
of R & D Market Strategy
Division CCXO,Co-CAIO
NTT,Inc.
Ms.Sachiko Oonishi



Founder/CEO
NPO Waffle
Ms.Sayaka Tanaka



Social Value Creation,
Partner
KPMG Consulting Co., Ltd.
Ms.Tae Aso



Director, R&D, Technology
Engagement
IBM Japan
Ms.Shizu Takahashi

15:00 - 16:00

HB-36

Convention Hall B

Ocean AI ~Trends in Ocean Innovation Beginning with the Visualization of the Ocean~



Organization for Marine
Science and Technology
Nagasaki University
Dr.Soyano Kiyoshi



Head of Converging
Technologies Laboratory
Fujitsu Limited
Ms.Akiko Yamada



Department of Logistics and
Information Engineering /
Professor
Tokyo University of Marine
Science and Technology
Dr.Tomoyuki Takenawa



Founder and CEO
NeuralX Inc.
Dr.Masaki Nakada

10:00 - 12:35

HA-31

Convention Hall A

5G/6G Special Day II Day 2 —5G Advancements, 6G Latest Developments and Outlook— Session 4 ~ Beyond 5G(6G) global trend ~

Latest Trends in Beyond 5G



Director
General of the International
Strategy Bureau, Ministry
of Internal Affairs and
Communications
Mr.Hideo Fuseda

6G : India Perspectives



Director General
Bharat 6G Alliance
Mr.Rajesh Kumar Pathak

B5G activities in Korea



Professor
DanKook University, Korea
Dr.LEE, HyeonWoo

Status of 6G Development in North America



Managing Director, ATIS Next G
Alliance
Alliance for Telecommunications
Industry Solutions (ATIS)
Mr.Jaydee Griffith

Update and Results from European 6G



Chairman of the Board
6G-IA
Dr.Colin Willcock

Way Forward for FCP towards 6G



Associate Provost (AI & Digital
Innovation) and Director
(Future Communications
Programme)
Singapore University of
Technology and Design
Dr.Tony Quek

Panel discussion



CSO, R&D Strategy
Department
NTT DOCOMO
Mr.Takehiro Nakamura



Professor, Graduate School of
Engineering
The University of Tokyo
Dr.Akihiro Nakao

Closing



Professor, Graduate School of
Engineering
The University of Tokyo
Dr.Akihiro Nakao

13:30 - 15:15

HA-34

Convention Hall A

5G/6G Special Day II Day 2 —5G Advancements, 6G Latest Developments and Outlook— Session 5 ~6G and AI ~

SoftBank's AI Infrastructure Strategy



Vice President, and Head
of the Research Institute of
Advanced Technology
SoftBank Corp.
Mr.Ryuji Wakikawa

Innovations in AI for B5G/6G Networks: KDDI's Challenge



General Manager, Wireless
Technology Division
KDDI Research, Inc.
Dr.Toshiaki Yamamoto

Expectation for AI native 6G Network



6G-Tech Department, Senior
Manager
NTT DOCOMO
Mr.Shinichi Isobe

NVIDIA's Vision for AI-Native 6G



Telecom BU
NVIDIA
Mr.Noda

Smarter Open RAN for the Beyond-5G Era



Innovation Program
Development Business
Department, General Manager
Rakuten Mobile, Inc.
Mr.Kuchitsu Mitsuhiro

Next-Generation Cyber Infrastructure Shaped by the Convergence of Communications and AI



Professor, Graduate School of
Engineering
The University of Tokyo
Dr.Akihiro Nakao

15:30 - 17:00

HA-36

Convention Hall A

5G/6G Special Day II Day 2 —5G Advancements, 6G Latest Developments and Outlook— Session 6 ~ 6G strategy session ~

MC



CSO(Chief Standardization
Officer)
NTT DOCOMO, Inc.
Mr.Takehiro Nakamura

Progress of Beyond 5G Fund Projects



PD, Innovative ICT Fund
Projects for Beyond 5G/6G
NICT
Mr.Kazuo Hagimoto



Technology & Research
Ericsson Japan K.K.
Mr.Yoshio Honda



Professor
The University of Tokyo
Dr.Akihiro Nakao



CTO
Ericsson Japan K.K.
Dr.Tsuyoshi Kashima



President
NICT
Dr.Hideyuki Tokuda



General Manager, Wireless
Technology Division
KDDI Research, Inc.
Dr.Toshiaki Yamamoto



Director, Global Strategy
Bureau, Technology Policy
Division
Ministry of Internal Affairs and
Communications(MIC)
Mr.Masayuki Matsui



Professor
Keio University
Dr.Tomoaki Otsuki



NICT
Ms.Eri Otsuka



Manager, Product Technology
Division Ubiquitous Network
Planning Division Business
Strategy Department Business
Planning Section 1
SoftBank Corp
Mr.Yuya Tsuda



Keio University
Dr.Tomoaki Otsuki



6G-Tech Department, Senior
Manager
NTT DOCOMO, Inc.
Mr.Shinichi Isobe



Ericsson
Mr.Tsuyoshi Kashima



Executive Director : Beyond5G
R&D Promotion Unit Director
General : Terahertz Technology
Research Center
NICT
Dr.Iwao Hosako

Closing remarks



Director
ARIB
Mr.Seiji Nishioka



Director, Space-Time
Standards Laboratory
NICT
Dr.Tetsuya Ido

Room 201 (R2), 2F International Conference Hall	Room 301 (R3), 3F International Conference Hall	E Stage in Exhibition Hall 6(ES)	T Stage in Exhibition Hall 4(TS)	AX Stage in Exhibition Hall 5 (AS)	NGP Stage in Exhibition Hall 6 (NS)
			10:15 - 11:15 TS-31		
10:30 - 11:00 R2-31 GENIAC ~ AI Project by METI #1	10:30 - 11:30 R3-31 Solution Service Market Trends and the state of business and human resource strategies in the Digital Era	10:30 - 11:30 ES-31 [Japan Patent Office] Exploring the Keys to Successful Open Innovation	Presentation by Regional Revitalization Support Team	10:30 - 11:30 AS-31 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	10:30 - 11:30 NS-31 Insights from Corporate Entrepreneurs: Spin-off Strategies and Startup Growth Potential
11:15 - 13:00 R2-32 GENIAC #2			11:30 - 12:10 TS-32		
	12:00 - 13:00 R3-33 A Practical Guide to Data-Aware IT Service Delivery	12:00 - 13:00 ES-33 NVIDIA DGX™ paves the way for future AI human resources development	Five Location Industry Experts discuss the Industry's "Evolution" and "Untapped Potential"	11:50 - 12:50 AS-32 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	11:45 - 12:45 NS-32 CEATEC × Japan Mobility Show Collaborative Stage: The Future of the Mobility Industry Accelerated by Digital Transformation
			12:30 - 13:10 TS-33		
			B2C company delivers smart experiences that fit into people's lives -- EDION's challenge to meet diversifying lifestyle needs		
13:30 - 14:30 R2-33 GENIAC #3	13:30 - 14:30 R3-34 Next-Generation Mobility from Japan: Insights of Entrepreneurs Driving New Technologies	13:30 - 14:30 ES-34 Utilization of big data information for social implementation of technology and innovation	13:30 - 14:10 TS-34 SOMPO's Challenge for Next-Generation Mobility	13:10 - 13:50 AS-34 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	13:00 - 14:00 NS-34 New Business Development and Open Innovation Strategy in Healthcare: Practical Approaches from Meiji and Daiichi Sankyo Healthcare
				14:10 - 14:30 AS-351 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	
14:45 - 15:45 R2-34 GENIAC #4	15:00 - 16:00 R3-36 Digital Decarbonization Strategy Toward 2030: Exploring Industry Responses to Market Trends in Scope 3 Emissions Disclosure	15:00 - 16:00 ES-36 AIST G-QuAT Strategic Plans for Industrial Application of Quantum Technology	14:30 - 15:10 TS-35 "Kao × @cosme Present: skin surface lipid-RNA Shaping the New Beauty Standard & the Co-Creation Consortium Roadmap"	14:45 - 15:05 AS-352 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	14:15 - 15:15 NS-35 How Venture Capitalists from Japan's Top Mega- Bank VCs View Startup- Corporate Co-Creation in a Rapidly Changing Market Environment
			15:30 - 17:00 TS-36	15:20 - 15:40 AS-361 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	
16:00 - 17:00 R2-35 GENIAC #5			The Future of Smart Homes: Sharing Lifestyle Data from IoT Home Appliances and Housing Equipment and Using it for Disaster Prevention TS-36 Creating the Future Data/ Cloud	15:55 - 16:15 AS-362 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	15:30 - 17:00 NS-36 CEATEC 2025 Next Generation Park Pitch Contest
				16:30 - 16:50 AS-37 One-Day Special Session Gathering All IPA Centers - Facing the Era of Data and AI: IPA's Challenges	

Pitch Stage in Exhibition Hall 5 (PS)

PS-31
VENTURE PITCH ONLINE CEATEC
Special Edition

PS-34
Touch-enabled next-generation 4D
imaging experience

PS-342
Next-Generation Patent Research
and Analysis with Generative AI,
introduction of Patentfield

PS-35
"Accelerating Business with Ready-
to-Work Talent!" High-Class Side Job
Talent Matching Service "lotsuf"

PS-351
VMFi Inc.

PS-361
Rescuing Aging Infrastructure!
A Maintenance Revolution with
Low-Power IoT × AI Anomaly
Detection

PS-362

Childcare Record System Utilizing ICT
in Iwate Prefecture

PS-373

A project aimed at restoring
communication for people with severe
disabilities who have lost speech,
providing them with accessible ways to
express themselves

Global Stage in Exhibition Hall 4 (GS)

GS-34
EU Pavilion Pitch :Digital Solutions
From Europe

GS-36
Latvia Pavilion Pitch :Digital
Innovations: From Cloud Intelligence to
Smart Mobility



10:30 - 11:30

HB-41

Convention Hall B

Osaka-Kansai Expo & Advanced Air Mobility— Inside the Future of Next-Generation Mobility



Senior Vice President
Domestic Business Promotion
Department
Mobility Innovation Team
ORIX Corporation

Mr. Ryo Sugiyama



DirectorLead, Business Development / Strategic Business Relationship
New Mobility Business Creation
Advanced Air Mobility Team
ANA HOLDINGS INC.

Mr. Yuki Horie

12:00 - 13:00

HB-43

Convention Hall B

Next-Generation Mobility × HMI/Displays



Automotive and Environmental Journalist

Ms. Yumi Kawabata



DCS Advanced Development
Department Executive Specialist

Mr. Yasuyuki GOTO



Visiting Professor, Global Research Institute for Mobility in Society
Nagoya University

Mr. Tsuguo Nobe



Nichia Corporation

Mr. Hajime Akimoto



Technology Strategy Promotion Division
Panel Semicon Laboratories
Senior Manager
SHARP Corporation

Mr. Daisaku Tarui

13:30 - 14:30

HB-44

Convention Hall B

A Prescription for Realizing Open Innovation: Challenges and Solutions for Co-Creation from the Perspective of Policy and Support



Startup Deputy Director
Innovation and Startup Promotion Division
Startup Promotion Office
Ministry of Economy, Trade and Industry

Mr. Yuya Suzuki



PrincipalHead of Future Tech-value Innovation Strategy Unit
ABeam Consulting Ltd.

Mr. Satoshi Tachibana



DirectorStartup Support Department
New Energy and Industrial Technology Development Organization

Mr. Kenji Wasada

15:00 - 16:45

HB-46

Convention Hall B

Carrying Forward Legacy of the Osaka-Kansai Expo: Shaping a New Future

Keynote Speech



Governor of Osaka Prefecture,
Mr. Hirofumi Yoshimura

Mr. Hirofumi Yoshimura



Director General of Sustainability Bureau
Japan Association for the 2025 World Exposition

Mr. Yasushi Nagami

Panel discussion



Governor of Osaka Prefecture,
Mr. Hirofumi Yoshimura

Mr. Hirofumi Yoshimura



Business Development Unit,
Business Creation Division,
Director
BIPROGY inc.

Mr. Hiroaki Miyake

Moderator



President & Representative Director
Osaka Metro Co., Ltd

Mr. Hideaki Kawai



Anchor:

Ms. Noriko Enokido



Vice-Chair
The Osaka Chamber of Commerce and Industry

Ms. Kyoko Hirose

10:30 - 11:30

HA-41

Convention Hall A

PAI – Positive Action Initiative: A Public-Private Challenge to Monetize Decarbonization



President
LBMA Japan Institute

Mr. Kuni Kawashima



Policy Planning, Corporate Strategy Office
Mercari, Inc.

Mr. Kentaro Fuse



Director, Deco-Katsu Support Team
Global Environment Bureau
Ministry of the Environment

Mr. Nobuhiko Shimizu



Section ManagerDigital Innovation Division
Solution Services Department
Business Solutions Headquarters
NTT DOCOMO Business, Inc.

Mr. Yoshiro Miyata



Regional Revitalization Division
Public Accounts Section
Consulting Team 2
Assistant Manager
Rakuten Group, Inc.

MR. Daiki Kanai



Earth Gift Project
PromotionPlanning & Development
Produce CenterCommunity Exchange Group, Planning & Development Section
JTB Corp.

Ms. Ayu Sakamoto

12:00 - 13:00

HA-43

Convention Hall A

"Transforming Manufacturing: From Gut Feeling to Data-Driven AI" ~Uncovering the Next Wave of Business Growth with Pioneering Companies~



Director Senior Managing Executive Officer
Sumitomo Chemical Co., Ltd.

Mr. Takanari Yamaguchi



President & CEO
AIST Solutions Co.

Mr. Seiji Oosaka



Chief Executive Officer
Stockmark Inc.

Mr. Tatsu Hayashi

13:30 - 14:30

HA-44

Convention Hall A

Why is creativity crucial in today's corporate R&D?— Dentsu's Executive Creative Director shares cases of playful R&D.



Executive Creative Director
Dentsu Lab

Mr. Naoki Tanaka



Creative Technologist

Mr. Shintaro Murakami



Communication Planner
Stockmark Inc.

Ms. Moe Goto

15:00 - 16:30

HA-46

Convention Hall A

The Value of Future Exploration in Business, Management, and Society



Co-Founder / Futurist
VISIONGRAPH Inc.

Ms. Maiko Mikagawa



Head of Creative Center
Creative Center, Sony Group Corporation

Mr. Daisuke Ishii



Head of Experience Design,
KOEL Design Studio,
Innovation Center
NTT DOCOMO BUSINESS, Inc.

Ms. Yumiko Tanaka



Editor at Large
WIRED JAPAN

Mr. Tomonari Cotani

Room 201 (R2), 2F International Conference Hall	Room 301 (R3), 3F International Conference Hall	E Stage in Exhibition Hall 6(ES)	T Stage in Exhibition Hall 4(TS)	AX Stage in Exhibition Hall 5 (AS)	NGP Stage in Exhibition Hall 6 (NS)
				10:30 - 12:00 AS-41 How to Go to Mars and Return to Earth	10:30 - 11:30 NS-41 Lab to Global: The University Startup Challenge
10:30 - 12:00 R2-41 IOFDS (International Open Forum on Data Society) Open Round Table	10:30 - 11:30 R3-41 Electronic Components Technology Roadmap to 2035: The Impact of Generative AI on Electronic Components	10:30 - 11:30 ES-41 "Unlocking Collective Intelligence: How to Leverage Visasq for Productivity - Insights from 30 Years at a Major Electronics Manufacturer and 2 Years at VisasQ"	10:30 - 12:10 TS-41 Digital Mobility for a Better Life: Expanding Innovative Products and Services	12:15 - 12:45 AS-43 Quantifying Correction Data Reveals the "Technological Innovation" of Excellent Companies	11:45 - 12:45 NS-42 Art × Cities × Enterprises
	12:00 - 13:00 R3-43 Future Society Pioneered in National Strategic Special Zones -Towards the Realization of a Data- Driven Society Starting from Osaka -	12:00 - 13:00 ES-43 The Current State and Future Outlook of IT and AI in Japan' s Premier Formula Car Racing	12:30 - 13:10 TS-43 Democratizing Marketing: How AI Accelerates Growth for All	13:00 - 13:35 AS-441 RIKEN' s Pioneering Efforts in "AI for Science" Fugaku- Driven 3D Generative AI for Structural Design: Integrating Simulation and Evolving towards FugakuNEXT	13:00 - 14:00 NS-44 Toray's Way of Creating the Future: Challenging the Creation of "Shin-Fiber Industry" through a Modern "Noren-wake"
13:00 - 16:00 R2-44 IDSA Data Spaces Discovery Day Tokyo in 2025-Connected Data, Moving the Future-	13:30 - 14:30 R3-44 Frontline GPU Utilization in Japan and the U.S.: Current Trends and Future Outlook for Generative AI	13:30 - 14:30 ES-44 From DX to AX: The Next Leap in Japan' s Innovation Journey	13:30 - 15:10 TS-44 Digital Transformation (DX) in the Public Sector: High Stakes, Tough Choices, and Bold Innovations Government DX in EU & Japan - Procurer & supplier dialogues	13:45 - 14:20 AS-442 RIKEN' s Pioneering Efforts in "AI for Science" Recent Advances in Quantum Chemistry: Simulation, AI, and Quantum Computing	14:15 - 15:15 NS-45 IBM x NEC: Why We're Taking on New Business Challenges
		15:00 - 16:00 ES-46 Enabling the Future of Mobility: ANRITSU' s Technological Approach to Accelerating EV Development	15:30 - 17:00 TS-46 "Powering Life, Connecting to the Future." ~ How Portable Batteries and EVs Can Keep Medical Care Running During Disaster- Related Power Outages. — What You Should Know Now. ~	14:30 - 15:05 AS-45 RIKEN' s Pioneering Efforts in "AI for Science" : Digital brain construction using large-scale brain data and supercomputers	15:30 - 17:00 NS-46 CEATEC 2025 Corporate Venturing & Spin-off Pitch Contest
				15:15 - 15:50 AS-46 RIKEN' s Pioneering Efforts in "AI for Science" : AI x Data Assimilation: Forecasting Guerrilla Rainstorms at the Osaka- Kansai Expo and Beyond	

Pitch Stage in Exhibition Hall 5 (PS) PS-411 Latest Developments in Domain-Specific LLMs PS-412 "Digitizing the Sense of Touch": A Highly Adaptable and Versatile Automation Solution with Real Haptics, Collaborative Robots, and a General-Purpose Multi-Jointed Hand. PS-421 Next-Generation Patent Research and Analysis with Generative AI: Introduction to Patentfield PS-422 Aokumo AI PS-423 Current Status of Location Information Analysis: From Urban Planning to Sales Forecasting PS-424 The More AI Advances, the More Bottlenecks Emerge	PS-43 Instant Core Body Temperature Risk Detection using Wearable Heat Flux Sensors PS-431 From Circuit Watching to Careful Prevention PS-432 Win in the AI Era! Real-World Examples Reveal "Today" and "What Lies Ahead" PS-433 Typed Higher-Order Logic for Generative AI Prompts and Its Applications PS-441 Generative AI Discovery! Harnessing Patent × Research Paper Big Data to Transform Strengths into New Business PS-442 Winning Strategies for Using Generative AI Agents: Insights from 2,000 Case Studies PS-443 Latest AI Use Cases Revealed Through Consultation Examples at AI Market	PS-444 Creating New Experiential Value in Insurance PS-451 Is robot a key for solving labor shortages? PS-452 Olfactory Media Using an Olfactory Display PS-453 Materials AI for Everyone - How the Democratization of MI Opens a New Era in Manufacturing PS-461 Disaggregation Ammeter and Action-Proposal EMS for Commercial and Industrial Sectors PS-462 [Junior and Senior High School Students] Winning Team Idea Pitch from MONO-COTO INNOVATION PS-463 "Digitizing Human Touch with Tactile-AI to Build the Next Global Standard in Manufacturing"	PS-464 From "Searching, Summarizing, and Reading Data" to "Just Ask": The Frontline of Conversational AI in the Workplace PS-47 Corporate Sales Promotion Utilizing Subsidies Global Stage in Exhibition Hall 4 (GS) GS-44 Ukraine Pavilion Pitch : Innovation From Ukraine GS-45 Ukraine IT Pavilion Pitch : IT-Related Innovation from Ukraine GS-46 Uzbekistan Pitch :Potential for IT outsourcing in Uzbekistan
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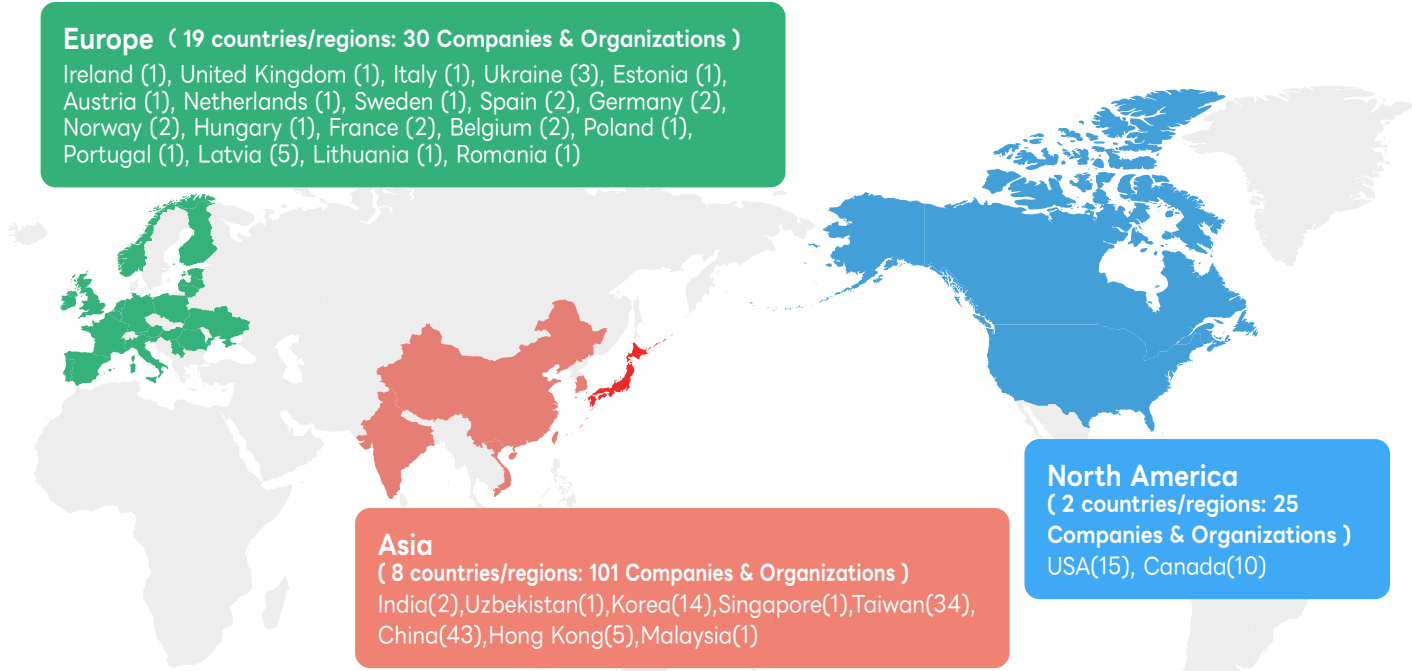
Performance Data

Exhibitor Profile

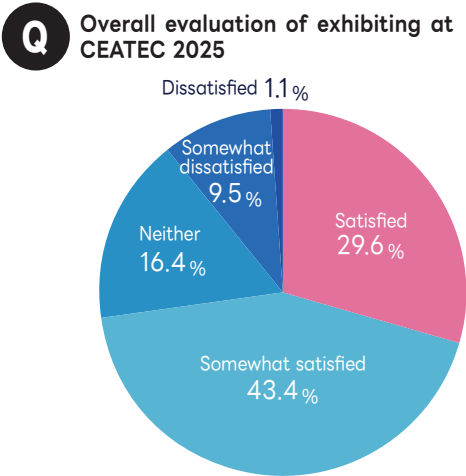
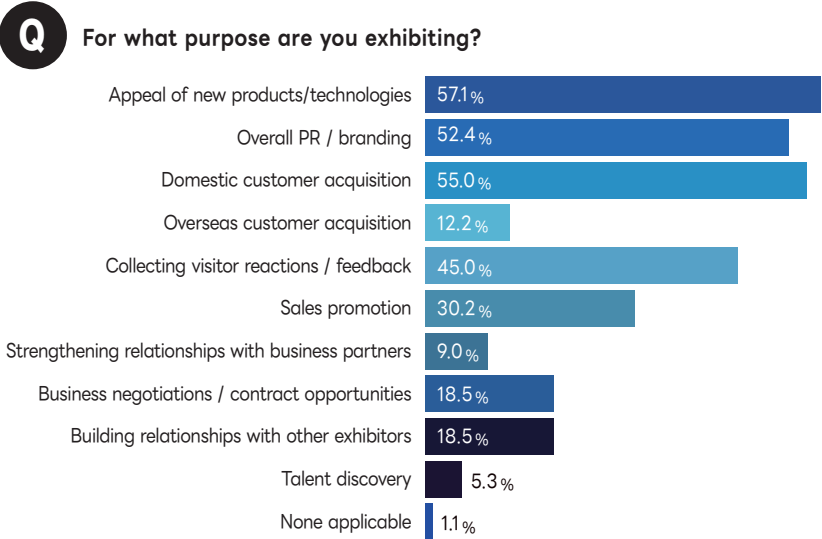
At a glance



Area	Exhibitor			booth
	Domestic	Overseas	Total	
Corporate/Organization Exhibition				
General Exhibits	334	88	422	865
Special Exhibits				
AX Park	25	8	33	100
Partners & Global Park	152	48	200	263
Next Generation Park	143	12	155	200
Total	654	156	810	1,428



Exhibitor Satisfaction Survey

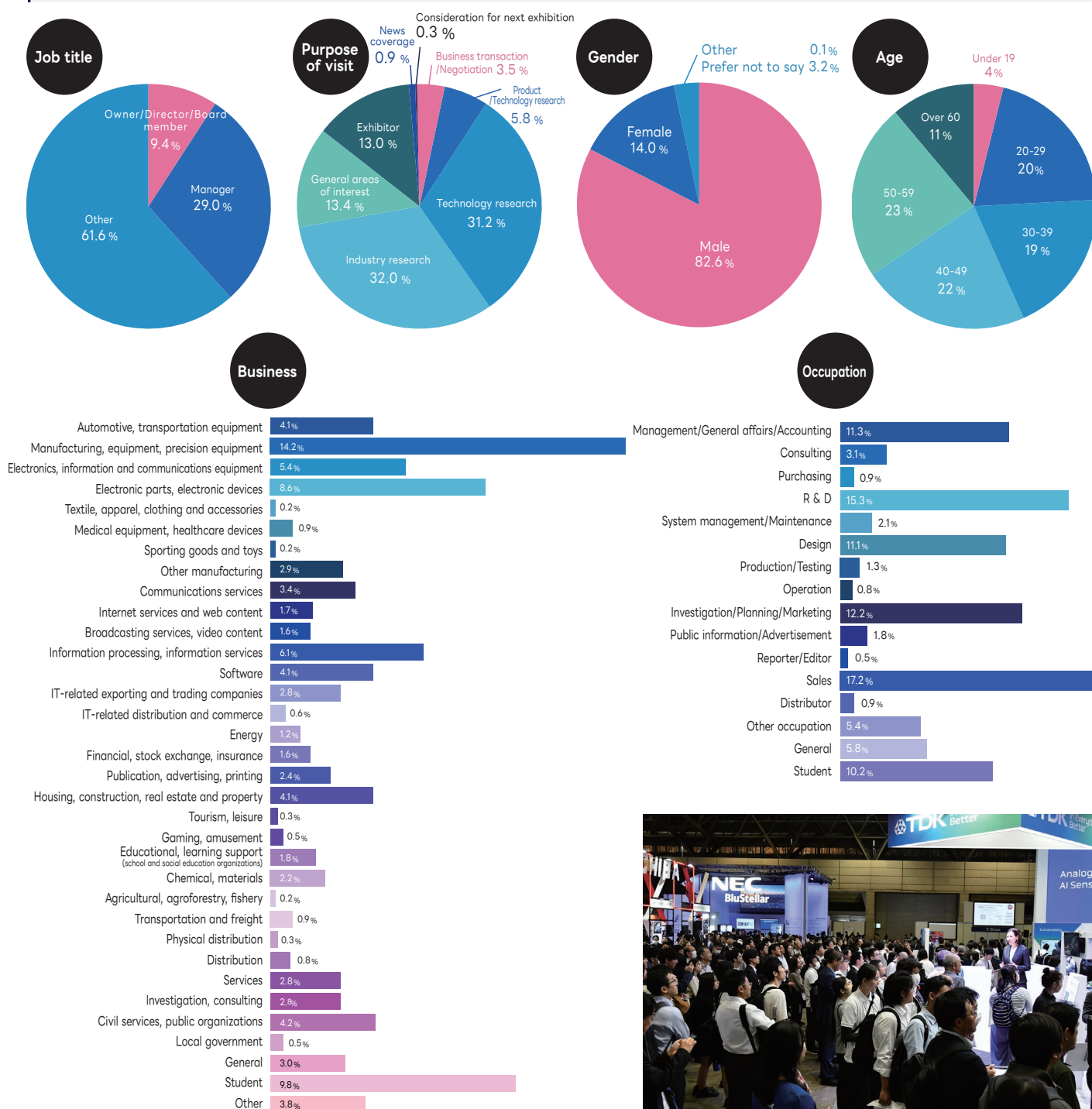


Visitor Profile

CEATEC 2025 Total registered visitors

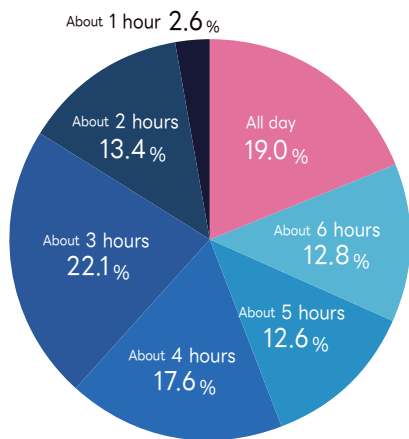
		10/14(TUE)	10/15(WED)	10/16(THU)	10/17(FRI)	Total
Date	Domestic Visitors	14,752	18,777	20,433	26,652	80,630
	Overseas Visitors	542	236	268	200	1,230
	Subtotal	15,294	19,013	20,701	26,852	81,860
	Press	340	116	79	100	635
	Exhibitor Staff	4,840	4,304	3,821	3,424	16,389
	Total	20,474	23,433	24,601	30,376	98,884

CEATEC 2025 Visitor Demographics Due to rounding, the sum of the percentage composition may not be exactly 100%.

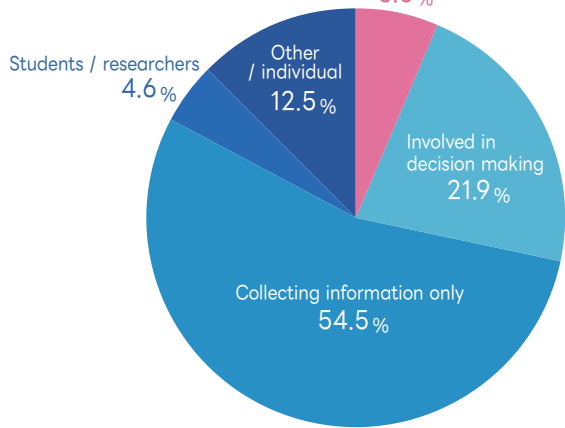


Visitor Survey Results

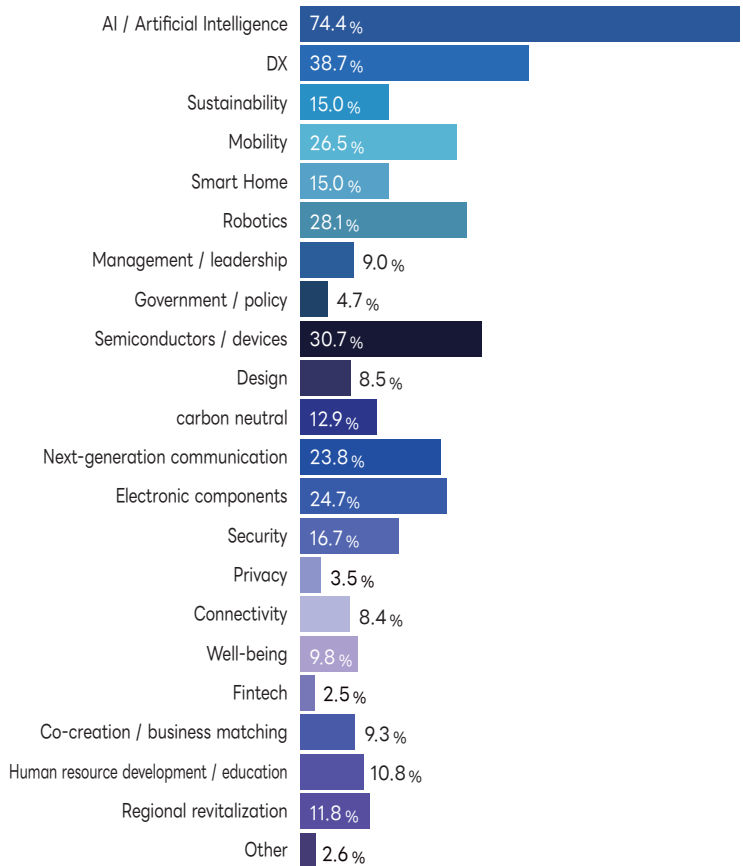
Q Please tell us how long you stayed at CEATEC 2025 (Makuhari Messe venue). If you visited for 2 days or more, please tell us the duration of the day you stayed the longest.



Q Budget / Purchasing Authority Final decision maker 6.5 %



Q Please tell us the keywords you noticed at CEATEC 2025 (Multiple Answers)



CEATEC Official Website Results

Total (Sept 1-Oct 31) * Number of Sessions: The number of times users visited a website within a specific period.
* Reference: Google Analytics

Impressions

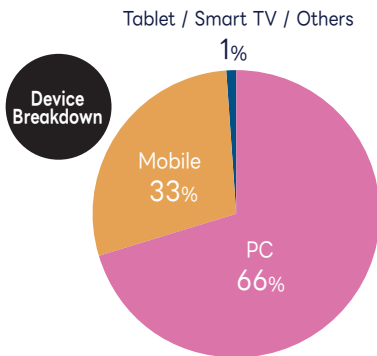
2,108,483

Sessions

721,680

Number of official email newsletter subscribers

Approximately **370,000** /delivery
Number of email newsletter distributions: **26**times (2025/1/20 - 2025/11/10)



Top Countries by Access
*Sessions

1 Japan	679,523	6 South Korea	2,099
2 United States	14,403	7 Hong Kong	1,230
3 China	9,209	8 India	1,155
4 Singapore	4,803	9 Germany	819
5 Taiwan	3,384	10 Ireland	814



PR & Promotion Data

Registered press

635 members

Online News Articles

Aggregation period: Aug 1 – Oct 31
Search terms: CEATEC news

Approx. **21,900**
articles

Online Videos (Youtube)

Aggregation period: Aug 1 – Oct 31
Search terms: CEATEC related videos

Approx. **1,200**
related videos

Domestic newspaper articles

Number of listings

300

Domestic Newspaper Headlines (Examples)

- » “Autonomous AI, Society’ s New Partner — CEATEC Opens” (Nikkei)
- » “New Technologies for a Richer Future — CEATEC Opens at Makuhari” (Yomiuri)
- » “AI Solutions to Support Work — CEATEC Opens” (Asahi)
- » “Toward the 6G Era — CEATEC Showcases Cutting-Edge Technologies” (Sankei)
- » “CEATEC Opens with AI at the Center — Record Participation from Startups and Universities” (Mainichi)
- » “CEATEC Opens — Cutting-Edge Tech to the Forefront” (Tokyo Shimbun)

TV and Radio Coverage (Domestic & Overseas)



TV coverage

47 programs, total **2** hours **26** minutes **54** seconds broadcast

Air Date	Station	Program	Time	CEATEC Time
10/6	NHK	NHK News Ohayō Nippon	07:00-07:45	2:03
10/10	NHK World	News Line	13:00-13:30 17:00-17:30	2:51
	BAYFM78	AWAKE	06:00-08:57	4:42
10/13	Nippon TV	newszero	23:00-23:59	0:55
	TBS	Hiruobi	10:25-13:55	1:23
	TBS	N-Suta	15:49-18:30	3:07
	Fuji TV	FNNLiveNewsdays	11:30-11:50	1:13
	Fuji TV	FNNLiveNews α	23:45-24:30	2:43
	TV Asahi	WIDE! SCRAMBLE(#1)	10:25-13:00	1:10
	TV Asahi	WIDE! SCRAMBLE(#2)	10:25-13:00	1:02
	Abema-TV	Abema News	04:00-07:00	0:57
	TV TOKYO	World Business Satellite	22:00-22:58	6:22
	BS TV TOKYO	World Business Satellite	23:00-24:00	6:22
10/14	NHK	News	13:00-13:05	2:02
	NHK	News / Weather news	14:00-14:05	0:44
	NHK	News / Weather news	15:00-15:07	0:28
	NHK	Shutoken Network	18:10-19:00	3:14
	NHK	News Watch 9	21:00-22:00	5:53
	Nippon TV	Oha ! 4 NEWSLIVE	4:30-5:50	0:51
	Nippon TV	newsevery	15:50-16:45	1:33
	Nippon TV	newsevery	17:53-19:00	0:15
	TBS	TBSNEWS	3:45-4:30	2:53
	TBS	THETIME(#1)	4:30-5:20	1:30
	TBS	THETIME(#2)	5:20-8:00	4:56
	TV Asahi	Good! Morning	4:55-8:00	1:35
	Abema-TV	Abema News	4:00-7:00	1:15
	TV TOKYO	News Morning Satellite	5:45-7:05	0:16
	TV TOKYO	World Business Satellite	22:00-22:58	6:15
	BSTV TOKYO	NIKKEI NEWS NEXT	21:00-22:00	4:11
	BSTV TOKYO	World Business Satellite	23:00-24:00	6:15
	Chiba TV	news Chiba 0600	18:00-18:25	1:51
10/15	NHK	NHK News Ohayō Nippon	5:00-8:00	1:18

Air Date	Station	Program	Time	CEATEC Time
10/15	Nippon TV	Oha ! 4 NEWSLIVE	4:30-5:50	1:36
	Nippon TV	Zip	5:50-9:00	6:39
	TBS	Hiruobi	10:25-13:55	18:47
	Fuji TV	Mezamashi TV	5:25-8:14	2:02
	TV Asahi	Good! Morning	4:55-8:00	3:47
	Abema-TV	Abema News	4:00-7:00	3:44
	BS TV TOKYO	Nikkei Morning Plus FT	7:15-8:00	5:18
10/16	Nippon TV	DayDay.	9:00-10:25	2:02
10/17	TV TOKYO	World Business Satellite	11:00-11:58	0:32
	BS TV TOKYO	World Business Satellite	12:00-13:00	0:32
	NHK Osaka	Hot Kansai	18:10-19:00	7:16
	tvk	tvk NEWS Harbor	18:00-18:30	1:48
	Radio Japan	HAPPY VOICE from YOKOHAMA	12:00-15:00	7:28
10/18	BS-TBS	Biz Square	11:00-11:54	2:32
10/19	TBS	Sunday Morning	8:00-9:58	5:20
	Fuji TV	Nichiyo Hodo THE PRIME	7:30-8:55	1:05
10/20	TOKYO MX	Wake Up7	7:00-7:30	3:40



TV and Radio Coverage

Air Date	Station	Program	Time	CEATEC Time
10/15	KTLA-5	Morning News (Rich On Tech)	04:00-12:00	2:47
	BBC	Business Today #1	10:38-	2:39
10/16	BBC	Business Today #2	10:38-	2:39
	BBC	Business Today #3	10:38-	2:39
10/18	KTLA-5	Morning News (Rich On Tech)	04:00-12:00	2:55
	KFI AM 640	Rich On Tech	11:00-14:00	11:20
10/19	710 WOR	Rich On Tech	08:00-11:00	11:20
Nov Schedule	CNBC Asia	Channel Japan	10:00-10:30	(To air)

Event Overview

Name	CEATEC 2025 Combined Exhibition of Advanced Technologies
Purpose	Aiming to realize “Society 5.0” , which will balance economic development and the resolution of social issues, people, technology, and information from all industries and sectors will gather to envision the future through “co-creation” .
Dates	10:00 AM - 5:00 PM, Tuesday, October 14 - Friday, October 17, 2025
Venue	Makuhari Messe (Mihama-ku, Chiba City, Chiba Prefecture)
Admission	Free of charge *Online registration is required for admission.
Organizer	Japan Electronics and Information Technology Industries Association (JEITA)
Co-organizers	Communications and Information network Association of Japan (CIAJ) Software Association of Japan (SAJ)
Supported by	<p>Ministry of Internal Affairs and Communications (MIC), Ministry of Foreign Affairs of Japan (MOFA), Ministry of Health,Labour and Welfare (MHLW), Ministry of Economy, Trade and Industry (METI), Ministry of Land, Infrastructure, Transport and Tourism (MLIT), Digital Agency</p> <p>(the order of establishment)</p> <p>Japan External Trade Organization (JETRO), New Energy and Industrial Technology Development Organization (NEDO), National Institute of Advanced Industrial Science and Technology (AIST), National Institute of Information and Communications Technology (NICT), Information-technology Promotion Agency (IPA), Organization for Small & Medium Enterprises and Regional Innovation,Japan (SME Support, Japan)</p> <p>Chiba Prefecture, Chiba City</p> <p>Japan Broadcasting Corporation (NHK) / Japan Commercial Broadcasters Association (JBA)</p> <p>Japan Business Federation (Keidanren) / Japan Automobile Manufacturers Association, Inc.,</p> <p>The Japan Chamber of Commerce and Industry The Tokyo Chamber of Commerce and Industry The Chiba Chamber of Commerce and Industry</p> <p>Embassy of the Republic of Latvia in Japan, Embassy of the Republic of Uzbekistan in Japan, Embassy of Ukraine in Japan, EU-Japan Centre for Industrial Cooperation, Ontario Trade and Investment Office, Embassy of Canada to Japan</p> <p>(list in no particular order)</p>
Operations	CEATEC Management Office (Japan Electronics Show Association)

